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**UNITED STATES  
SECURITIES AND EXCHANGE COMMISSION  
Washington, D.C. 20549**

**FORM 8-K**

**CURRENT REPORT**

**Pursuant to Section 13 OR 15(d) of The Securities Exchange Act of 1934**

**Date of Report (Date of earliest event reported) March 17, 2009**

**Brush Engineered Materials Inc.**

(Exact name of registrant as specified in its charter)

Ohio

(State or other jurisdiction  
of incorporation)

001-15885

(Commission  
File Number)

34-1919973

(IRS Employer  
Identification No.)

6070 Parkland Blvd., Mayfield Hts., Ohio

(Address of principal executive offices)

44124

(Zip Code)

Registrant's telephone number, including area code 216-486-4200

Not Applicable

(Former name or former address, if changed since last report.)

Check the appropriate box below if the Form 8-K filing is intended to simultaneously satisfy the filing obligation of the registrant under any of the following provisions (see General Instruction A.2. below):

- ☐ Written communications pursuant to Rule 425 under the Securities Act (17 CFR 230.425)
  - ☐ Soliciting material pursuant to Rule 14a-12 under the Exchange Act (17 CFR 240.14a-12)
  - ☐ Pre-commencement communications pursuant to Rule 14d-2(b) under the Exchange Act (17 CFR 240.14d-2(b))
  - ☐ Pre-commencement communications pursuant to Rule 13e-4(c) under the Exchange Act (17 CFR 240.13e-4(c))
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**Item 7.01 Regulation FD Disclosure**

On March 17, 2009, Brush Engineered Materials Inc., an Ohio corporation (the “Company”), updated the “Current Investor Update,” a slide presentation on its website, a copy of which is attached hereto as Exhibit 99.1. This slide presentation shows the Company’s corporate strategy and the financial results through the fourth quarter of 2008.

**Item 9.01 Financial Statements and Exhibits**

Exhibits:

<u>Exhibit Number</u>	<u>Description of Exhibit</u>
99.1	Current Investor Update

## SIGNATURES

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

Brush Engineered Materials Inc.

March 17, 2009

By: Michael C. Hasychak  
Michael C. Hasychak  
Vice President, Treasurer and Secretary

## *Forward-Looking Statements*

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These slides contain “forward-looking statements” within the meaning of the Private Securities Litigation Reform Act of 1995. These statements involve known and unknown risks, uncertainties and other factors that could cause the actual results of the Company to differ materially from the results expressed or implied by these statements, including health issues, litigation and regulation relating to our business, our ability to achieve profitability, significant cyclical fluctuations in our customers’ businesses, competitive substitutes for our products, risks associated with our international operations, including foreign currency rate fluctuations, energy costs and the availability and prices of raw materials and other factors disclosed in periodic reports filed with the Securities and Exchange Commission. Consequently these forward-looking statements should be regarded as the Company’s current plans, estimates and beliefs.

The Company does not undertake and specifically declines any obligation to publicly release the results of any revisions to these forward-looking statements that may be made to reflect any future events or circumstances after the date of such statements or to reflect the occurrence of anticipated or unanticipated events.



# *Brush Engineered Materials Inc.*

## *Profile*

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- Publicly traded since 1956: NYSE-listed since 1972
- Founded 1931 as Brush Beryllium Company, recently celebrated 75th anniversary
  - Building off earlier pioneering technical work at Brush Laboratories
  - Initial scope was development of commercial markets
- With onset of WW II and post war period, significant growth in defense and eventually, aerospace applications
- Mid-70s: major expansion of new commercial markets including automotive electronics, telecommunications and computer
- Today, commercial markets represent over 90% of revenues\*

\*See 2008 Revenue by Market



# *Brush Engineered Materials Inc. Profile*

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- A leading manufacturer of high performance specialty engineered materials and services ... *an enabling materials technology company*
- Four segments...with operations, service centers and major office locations in North America, Europe and Asia
- Serving long-term growth oriented global markets from consumer electronics to heavy mining equipment



# *Brush Engineered Materials – Core Competency*

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## **A common approach to markets and a common culture across our operating companies**

- Collaborating with customers worldwide to solve material application challenges ... *with a focus on enabling technology and services*
- "Own" a Niche orientation ... non-commodity
- Focus on global growth and service
- Constantly looking ahead to realign product and service portfolios towards favorable trends ... targeted to achieve strong profitable growth
- Employees who are *passionately* focused on exceeding customer expectations



# Overview

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- Company: Brush Engineered Materials Inc.  
founded 1931, publicly traded since 1956
- NYSE Ticker: BW
- Shares Outstanding: Approximately 20.1 million at 12/31/08
- Market Cap: Approximately \$256 million at 12/31/08
- Component of: S&P Super Composite 1500, Russell 2000  
S&P Small Cap 600
- Annual Revenue: \$910 million @ 12/31/08
- Diluted EPS (GAAP): \$0.89 which includes certain non-operating  
items. The operating run rate is \$1.44\*
- Debt to Total Capitalization: 11% at 12/31/08

\*See Reconciliation of Non-GAAP Financial Measures





## 2008 Recap

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- Sales of \$910 million
- Diluted earnings per share of \$0.89\* (GAAP)
- Acquisition of assets of Techni-Met, Inc. for \$86.5 million
  - Techni-Met produces precision precious metal coated flexible polymeric films used in a variety of high-end applications, including diabetes diagnostic test strips.
- Contract with Government to build new beryllium pebbles plant
- Perpendicular media product qualifications progressing

\*Includes certain non-operating items. The operating run rate is \$1.44. See Reconciliation of Non-GAAP Financial Measures.



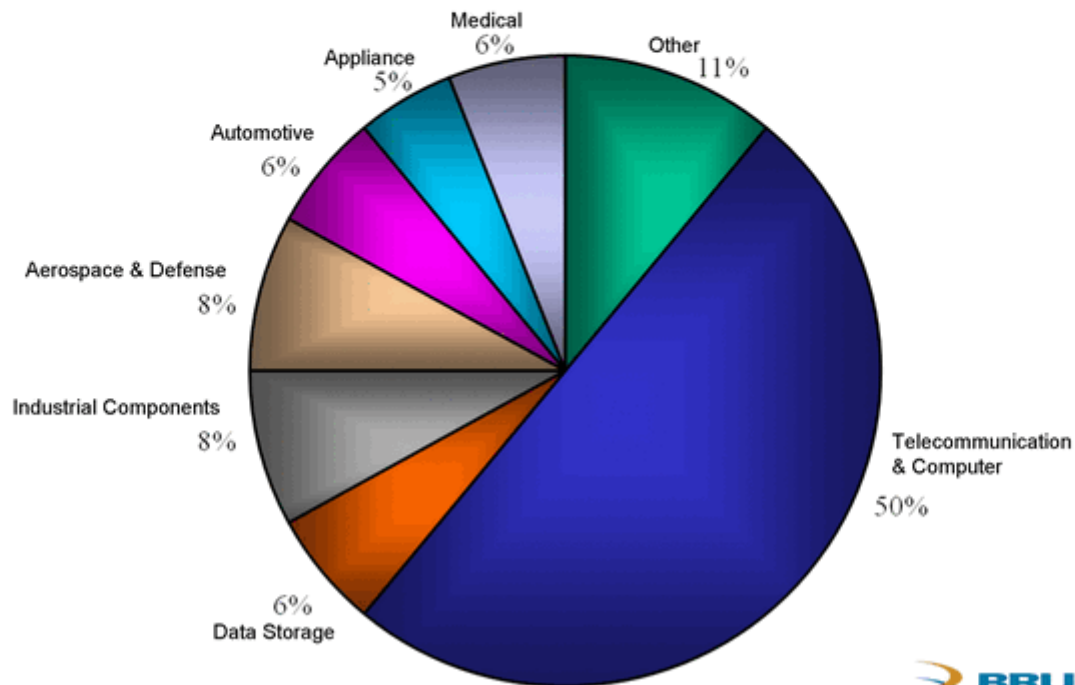
# Reconciliation of Non-GAAP Financial Measures

	Fourth Quarter Ended		Twelve Months Ended	
	<u>Dec. 31, 2008</u>	<u>Dec. 31, 2007</u>	<u>Dec. 31, 2008</u>	<u>Dec. 31, 2007</u>
GAAP Diluted EPS	(\$0.16)	0.60	\$0.89	\$2.59
Benefit on sale of ruthenium inventory	0.00	0.00	0.00	(0.70)
Lower of cost of market ruthenium inventory charge	0.30	0.02	0.50	0.15
Loss on sale of a subsidiary	0.00	0.00	0.00	0.02
Accounts receivable correction related to 2007	0.00	(\$0.04)	0.09	(0.09)
Discrete tax items & other	0.00	0.00	(0.06)	0.00
Non-recurring purchase accounting costs	0.00	0.00	0.02	0.00
Litigation settlement in 2007	0.00	(0.27)	0.00	(0.27)
Non-GAAP Operating Run Rate	\$0.14	\$0.31	\$1.44	\$1.70

# *Global Leader in High Performance Engineered Materials*

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## 2008 Revenue by Market



# *Strength in Challenging Times*

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## **Balance Sheet as of 12/31/08**

- Revolver
  - \$240 mm committed facility, matures November 2012
  - More than \$200 million in availability

## **Markets**

- Market Strength
    - Stronger position in medical, defense, optics and solar
    - Market diversification in wireless and photonics, telecommunication and computer, oil & gas, heavy equipment and aerospace
-

# *Advancing the World's Technologies*

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- Strong customer collaboration ... providing enabling technology solutions and service
- Materials that meet design challenges requiring
  - Strength
  - Electrical conductivity
  - Weight reduction
  - Reflectivity
  - Reliability
  - Miniaturization
  - Corrosion resistance
  - Thermal conductivity
- Targeting profitable growth applications in growing markets



# Typical End Uses

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Notebook computers  
& network servers

Defense



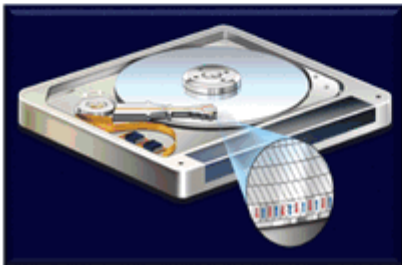
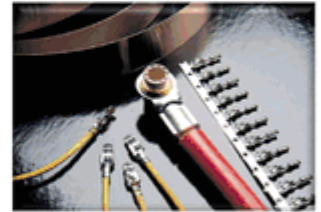
Cellular phones, i-Pods™ and other  
wireless communication devices



Commercial  
Aerospace



Electronic components  
in cars and trucks

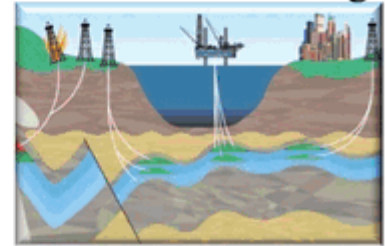


Data Storage

Medical  
Devices



Industrial products for  
Oil & Gas and Mining



 **BRUSH**  
ENGINEERED MATERIALS

# Applications - Cell Phones

## Grounding Clips and Audio Jacks (Alloy):

- Brush 60
- Alloy 25/190/290

## Internal Antenna Contacts (Alloy):

- Brush 60/17410
- Alloy 25/190/290

## Internal Electronics (WAM):

- Thin Film Materials – Power amplifiers, SAW and BAW devices, filters, and IC's
- Frame Lid Assemblies for SAW
- Thin Film Material for backlight applications using LED technology
- Shield Cleaning

## Micro Mezzanine Connectors for LCD Screen (Alloy):

- Brush 60

## Battery Contacts (Alloy):

- Brush 60
- Alloy 25/190/290

## I/O Connector Contacts (Alloy):

- Brush 60/17410
- Alloy 25/190/290

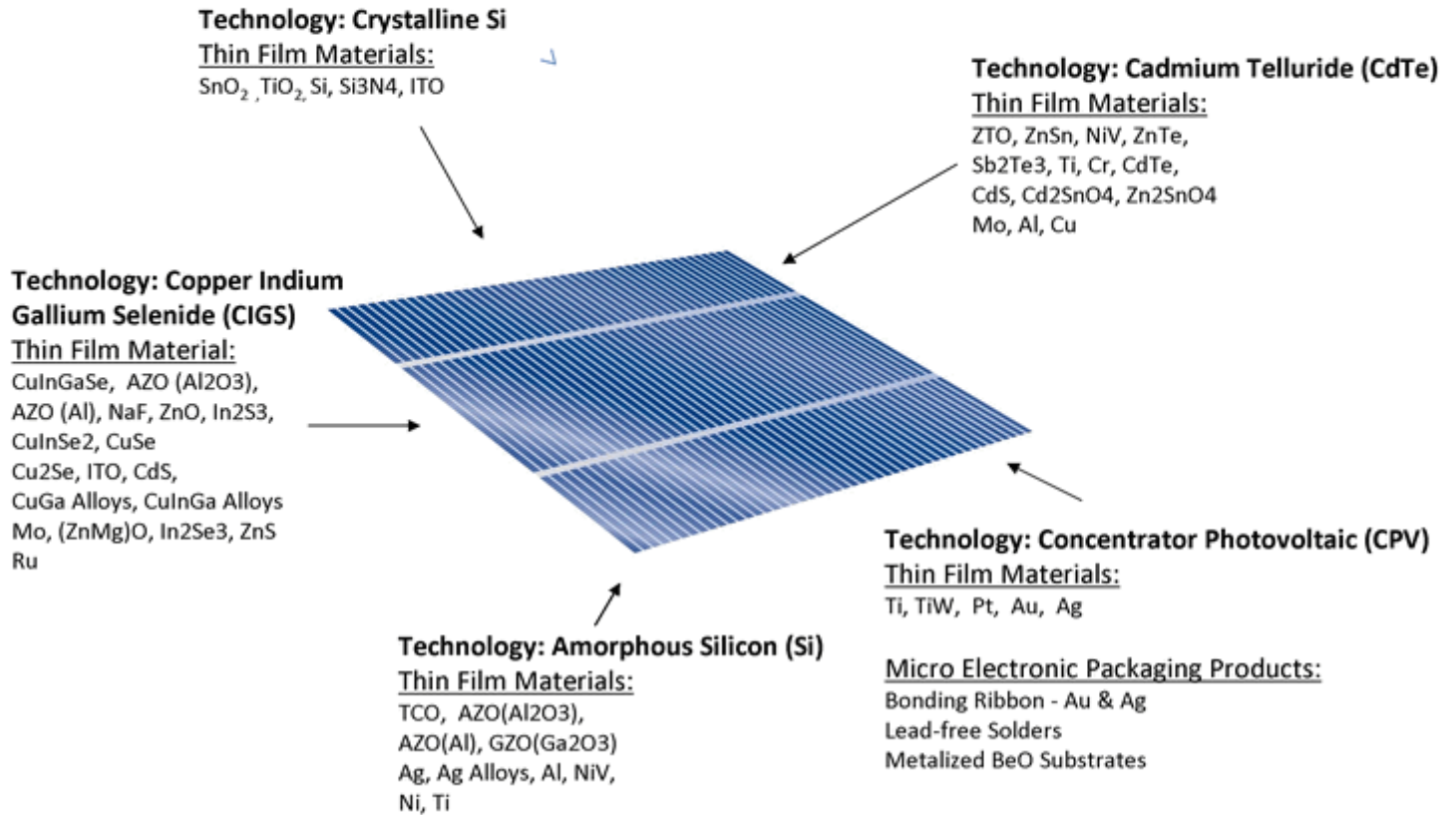
## Other Cell Phone Applications:

- **Circuit Board and IC Inspection** (Electrofusion/ Be Products):
  - PF-60 Be; IF-1 Be; AlBeMet 162
- **RoHS Compliance Assurance** (Electrofusion):
  - PF-60 Be; IF-1 Be



# Applications – Photovoltaic (Solar)

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# Applications – Oil & Gas

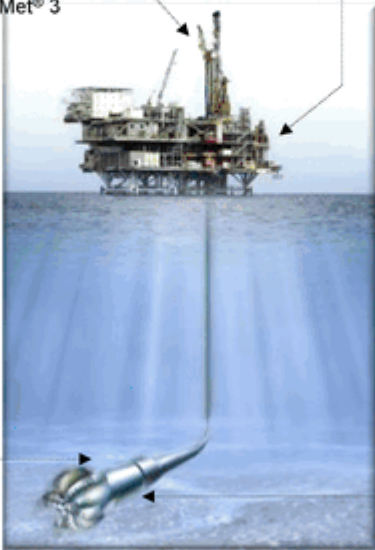
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## Wellhead Control Equipment (Alloy):

- Brush Alloy 25
- ToughMet® 3

## Structural Rig Components (Alloy):

- ToughMet® 3



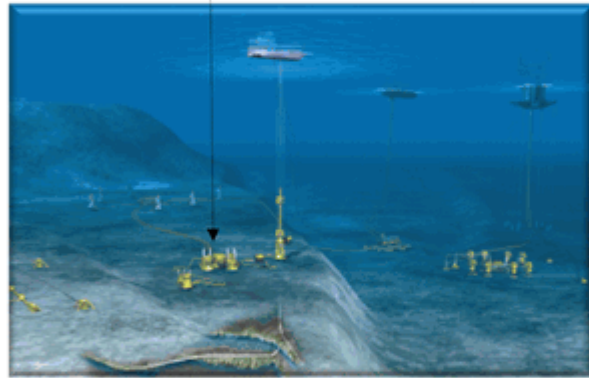
## Drill Bits (Alloy):

- Brush Alloy 25
- ToughMet® 3

## Directional Drilling Equipment (Alloy):

- Brush Alloy 25
- ToughMet® 3

MWD, LWD, MPT Systems



## Under Water Wellhead Equipment (Alloy):

- Brush Alloy 25
- ToughMet® 3

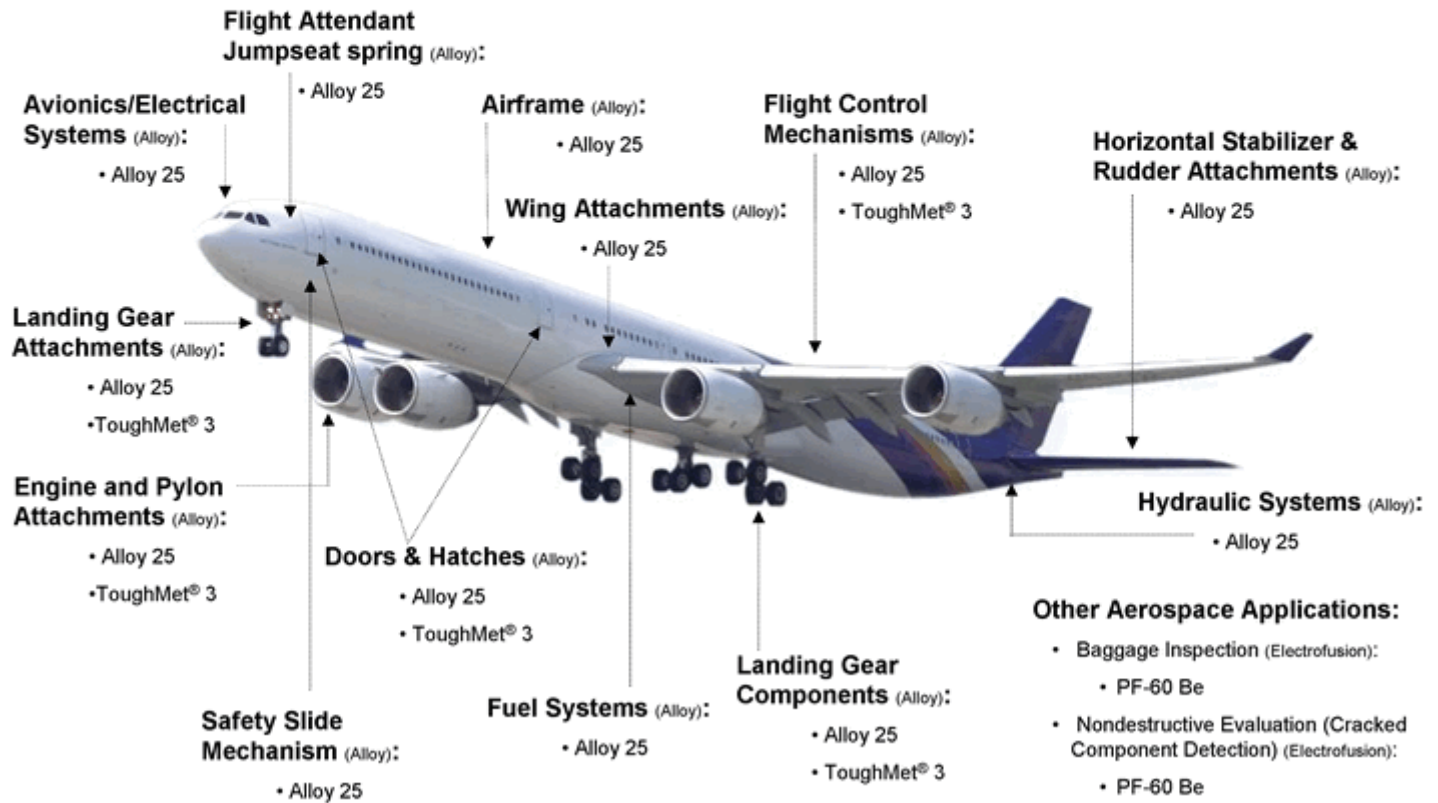
Blow out preventers, hydraulic actuators

## Other Oil & Gas Applications:

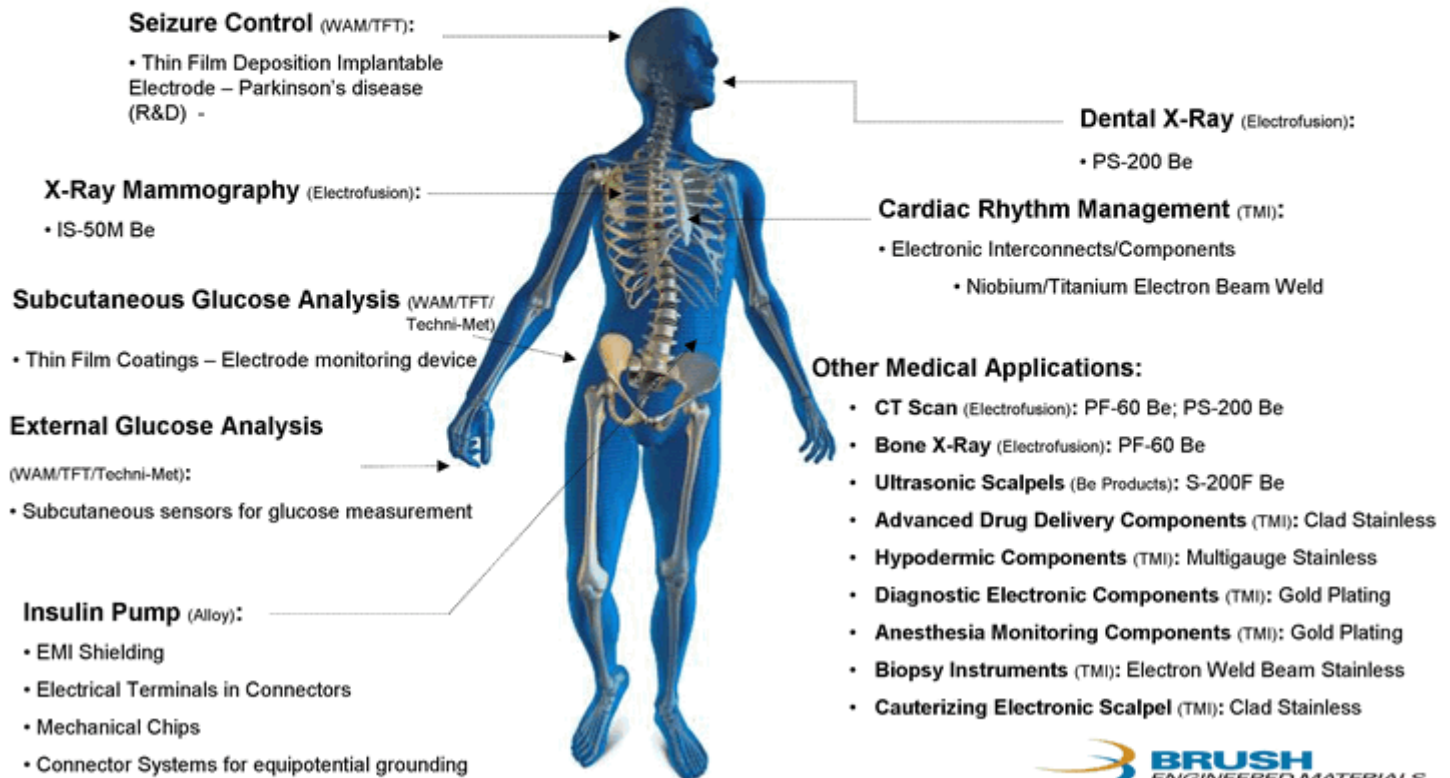
- In Situ Elemental Analysis (Electrofusion):
  - PF-60 Be; IF-1 Be
- Down Hole X-Ray Inspection (Electrofusion):
  - PS-200 Be

# Applications – Aerospace

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# Applications – Medical



## *Investment Highlights and Strengths*

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- Global Leader in High Performance Engineered Materials
- Unique Status as Fully Integrated Provider of Beryllium-Containing Products
- Broad Metallurgical Capabilities in Precious and Non-precious Metals
- Global Sales and Distribution Network
- Sales Based on End User Specifications
- Niche Oriented Product Offerings
- Strong Value Proposition in Served Markets
- Strategic Customer Relationships
- Significant Technical Capabilities
- Positive Long-term Market Trends
- Strong Growth in New Products, a culture of Innovation
- High Barriers to Entry
- Capacity to Support Profitable Market Growth
- Strong Balance Sheet
- Strong Cash Flow



# *Brush Engineered Materials Inc.*

## *Organized into Four Separate Reportable Segments*

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- **Advanced Material Technologies and Services**

Advanced Material Technologies and Services consists of Williams Advanced Materials Inc. (WAM)

- **Specialty Engineered Alloys**

The Specialty Engineered Alloys segment consists of Alloy Products which includes bulk and strip form copper-based alloy products, hydroxide and the Company's line of ToughMet® materials

- **Beryllium and Beryllium Composites**

The Beryllium and Beryllium Composites segment consists of Beryllium Products including beryllia ceramic manufactured by Brush Ceramic Products Inc.

- **Engineered Material Systems**

The Engineered Material Systems segment is comprised of Technical Materials, Inc.



# *Advanced Material Technologies and Services*

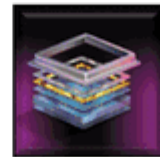
## *Q4 2008 Sales: \$94.9 million*

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### **Williams Advanced Materials (WAM)**

**\$94.9 million; 48%**

- Precious, non-precious and specialty metal products for high reliability applications
- Products include precious and non-precious metal vapor deposition targets, frame lid assemblies, clad and precious metal preforms, high temperature braze materials, ultra fine wire, sealing lids for the semiconductor/hybrid markets and specialty inorganic materials
- Industries served include magnetic and optical data storage, semiconductor, performance film, wireless, photonics, precision optics and medical





## *Specialty Engineered Alloys*

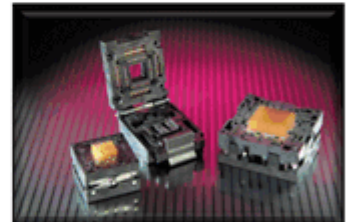
### *Q4 2008 Sales: \$68.0 million*

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#### **Alloy Products**

**\$68.0 million; 35%**

- Copper and nickel-based alloy materials, most of which incorporate beryllium
- Strip products are used in electronic connectors including PDA's, wireless communications equipment, notebook and network computers and automotive electronics that require high strength, formability and electrical conductivity
- Bulk products are rod, bar, tube and plate products for heavy equipment and aerospace bushings and bearings, oil & gas components and plastic mold materials where strength, corrosion and wear resistance, thermal conductivity and lubricity are critical performance requirements



## *Beryllium and Beryllium Composites*

### *Q4 2008 Sales: \$17.9 million*

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#### **Beryllium Products**

**\$17.9 million; 9%**

- Pure beryllium and aluminum-beryllium composites for a variety of high-performance applications in the defense, space, industrial, scientific equipment, electronics (including acoustics), medical, automotive electronics and optical scanning markets, where stiffness, strength, lightweight, dimensional stability, reflectivity and x-ray/nuclear properties are critical.





## *Engineered Material Systems*

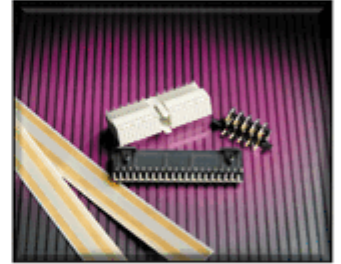
### *Q4 2008 Sales: \$12.0 million*

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#### **Technical Materials, Inc. (TMI)**

**\$12.0 million; 6%**

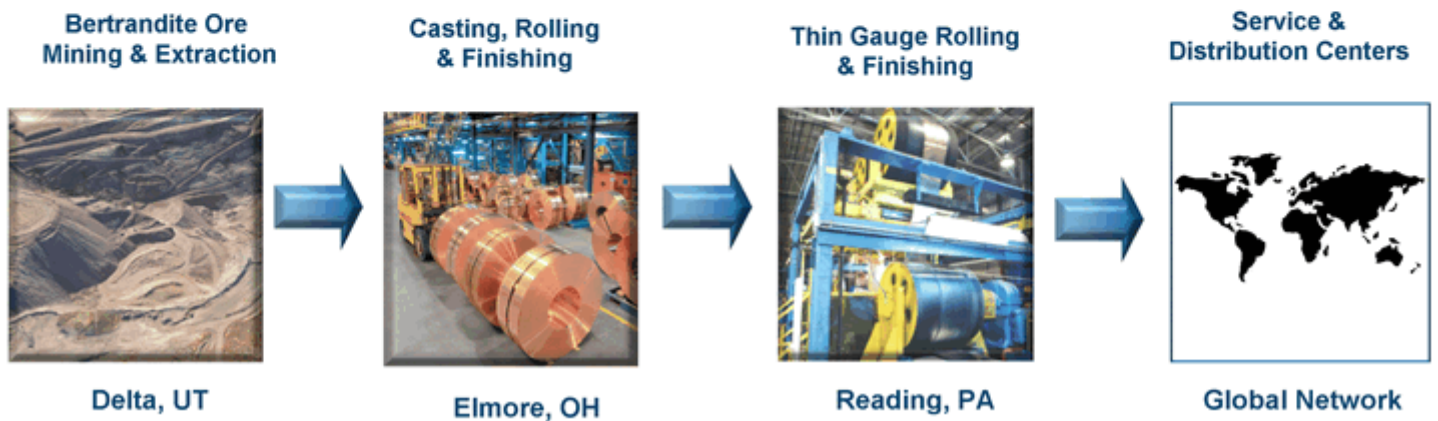
- Engineered material systems, including clad, plated and electron beam welded metals used in demanding connector applications
- Combines precious and non-precious metals in strip form for use in complex electrical components for telecommunications and computer systems, data storage, automotive electronics, semiconductors, energy, defense and medical applications



# *Fully Integrated Beryllium Producer*

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- Beryllium and beryllium alloys are critical to many high performance applications
  - Strong
  - Lightweight
  - Good formability
  - High reliability
  - Thermal and electrical conductivity
  - Corrosion and wear resistant
- Operate the only active bertrandite ore mine in the developed world
  - 7,500 acres in Juab County, Utah
  - Approximately 100 years of proven reserves



## *Key Financial Statistics*

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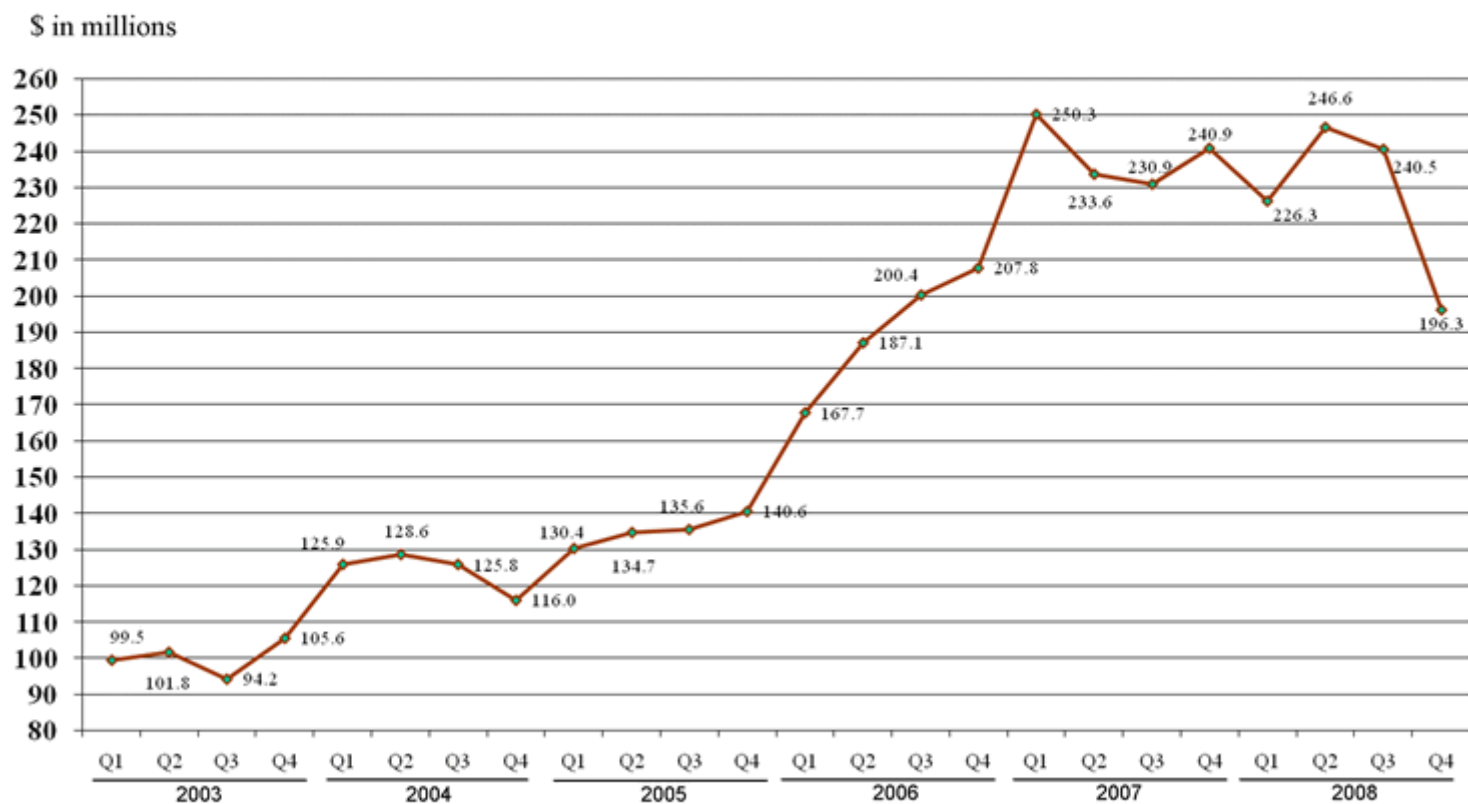
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\$ in millions	<u>2005</u>	<u>2006</u>	<u>2007</u>	<u>2008</u>
Sales	\$541.3	\$763.1	\$955.7	\$909.7
EBIT	19.5	43.8	84.5	28.1
Interest	6.4	4.1	1.8	2.0
Taxes	(4.7)	(9.9)	29.4	7.7
EPS	0.92	2.45	2.59	0.89
G.P.%	20.3%	21.2%	20.6%	16.7%
O.P.%	3.6%	5.7%	8.8%	3.1%
Depreciation & Amort.	21.7	24.6	23.9	33.8
Capital Spending*	13.8	15.5	30.1	27.9
Debt	57.2	49.0	35.5	41.8
Cash	10.6	15.6	31.7	18.5
Debt/Total Cap.	21%	15%	9%	11%

\*Net of reimbursements under government contracts in 2007 and 2008

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# Historical Revenue by Quarter



## *Long-term Positive Market Trends*

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- Electronic component manufacturers are being driven by end user demands to produce products that are smaller, lighter, faster and have more functionality
  - Increased electronic component performance characteristics require materials that have enhanced mechanical, electrical and thermal properties
  - Opportunity for growth in thin film physical vapor deposition (PVD) products in the data storage, semiconductor, solar and medical markets
  - Increasingly rigorous material requirements in the aerospace, defense, oil & gas and renewable energy markets continues to drive growing demand for high performance copper alloys
-

# *Capacity to Support Profitable Market Growth*

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*Well-positioned to support rapid sales growth with minimal incremental cash investment*

- Operating with available excess capacity in Alloy Products
  - WAM's Brewster, New York facility doubled its capacity in 2007
  - Brush Wellman Inc.'s Elmore, Ohio facility is partnering with the U.S. Department of Defense for the construction and start up of a \$90.4 million primary beryllium facility. Brush Wellman's contribution for this expansion, including the research and development, technology, land, buildings and ongoing operations is valued at \$23.2 million. Construction began in July of 2008 and is expected to be completed in April 2010.
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## *Our ongoing value creation initiatives are focused in three key areas*

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### Growth

- Expanding and diversifying the revenue base
  - Targeting profitable niche growth applications in growing markets
  - New product innovation and service
- Ongoing global expansion
- Strategic acquisitions, fast accretion

### Margin Improvement

- Lean Sigma-driven operating efficiency improvement
- New higher value added products
- Cost reductions

### Fixed and Working Capital Utilization

- Inventory turn improvement
  - Lean Sigma-driven factory utilization gains
-

## *New Products - Growing Applications*

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<u>Product</u>	<u>Market</u>	<u>Driver</u>	<u>Division</u>
PVD Magnetic Media	Hard Disk Drive	Increase Storage capacity	WAM
PVD – UMB	Consumer Electronics	Miniaturization	WAM
PVD - Evap Pro™ III	Compound Semi-conductor	Miniaturization	WAM
Chamber Service	PVD Customers	Service demands	WAM
PVD - Visilid	Optics	IR Wavelength	WAM
Eco-Ru™ Sputtering Target	Hard Disk Drive	Lower of Cost Ownership	WAM
Thin Film	Medical	Lower Cost of Ownership	WAM
Thin Film	Solar	Building Integrated & Photovoltaic	WAM

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## *New Products - Growing Applications*

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<u>Product</u>	<u>Market</u>	<u>Driver</u>	<u>Division</u>
Precious Metal Rod	Medical	Miniaturization	WAM
PVD Solar Materials	Solar	Thin Film Solar (cost/watt)	WAM
Alloy 390 Strip	Portable Electronics	Miniaturization and Reliability	Alloy
ToughMet®	Oil & Gas, Aerospace, Heavy Equipment	Reliability	Alloy
Li Ion Battery Interconnects	EV, HEV and commercial battery packs	Increasing energy density	TMI
Clad Stainless- Aluminum Strip	Hard Disk Drive Capacity	Increase Storage	TMI

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## *New Products - Growing Applications*

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<u>Product</u>	<u>Market</u>	<u>Driver</u>	<u>Division</u>
Truextent™ speaker domes	Professional Audio	Improved acoustic performance	Be
High purity beryllium	Semi-conductor	Increase lifetime	Be
AlBeWeld fabricated Structures	Defense and aerospace	Improved cost and delivery	Be

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## *Balance Sheet*

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(\$ in millions)

	<u>2004</u>	<u>2005</u>	<u>2006</u>	<u>2007</u>	<u>2008</u>
Balance Sheet Debt**	\$ 72.5*	\$57.2	\$48.9	\$35.5	\$41.8
Debt to Debt Plus Equity	26%	21%	15%	9%	11%

\*2000 Balance Sheet debt includes major equipment lease

\*\*Note - Excludes precious metal consignment  
and other leases of:               \$30.2       \$55.5       \$72.1       \$80.0       \$104.1

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# Segment Sales Review

\$ in millions

	2006		2007		2008	
	\$	%	\$	%	\$	%
Advanced Material Technologies and Services	\$343.4	45%	\$519.9	54%	\$466.4	51%
Specialty Engineered Alloys	275.6	36%	290.0	30%	299.9	33%
Beryllium and Beryllium Composites	57.6	7%	60.5	6%	63.6	7%
Engineered Material Systems	68.7	9%	70.9	7%	65.9	7%
Other	<u>17.8</u>	<u>3%</u>	<u>14.4</u>	<u>3%</u>	<u>13.9</u>	<u>2%</u>
TOTAL	\$763.1	100%	\$955.7	100%	\$909.7	100%



# Segment Earnings

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\$ in millions

	<u>2006</u>	<u>2007</u>	<u>2008</u>
Advanced Material Technologies and Services	\$30.5	\$59.4	\$10.3
Specialty Engineered Alloys	7.9	7.6	5.8
Beryllium and Beryllium Composites	7.4	7.8	8.4
Engineered Material Systems	2.7	4.7	5.9
Other	<u>(4.7)</u>	<u>5.0*</u>	<u>(2.3)</u>
TOTAL	\$43.8	\$84.5	\$28.1

\* The Other segment earnings of \$5.0 million in 2007 is primarily due to a gain in Q4 recorded as a result of a legal settlement



*Brush Engineered Materials Inc.*  
*Organized into Four Separate Reportable Segments*

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- *Advanced Material Technologies and Services*
  - Specialty Engineered Alloys
  - Beryllium and Beryllium Composites
  - Engineered Material Systems
-

# *Advanced Material Technologies and Services (Williams Advanced Materials Inc.) Vision*

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- Globally Recognized High Quality/Technology Supplier of Products and Services for “State Of The Art”, Emerging and Leading Edge Markets and Industries.
- Williams will Create a “Unique” Business Model with its Central Focus being to Relentlessly Strive for Product Differentiation through a Combination of Technology, Services and Quality, Providing “Remarkable” Solutions.
- Our Business Values and Corporate Integrity will be the Cornerstone of the way we relate to our Customers, Partners, Suppliers, the Communities we Reside and most Importantly our Employees.



# *What We Do*

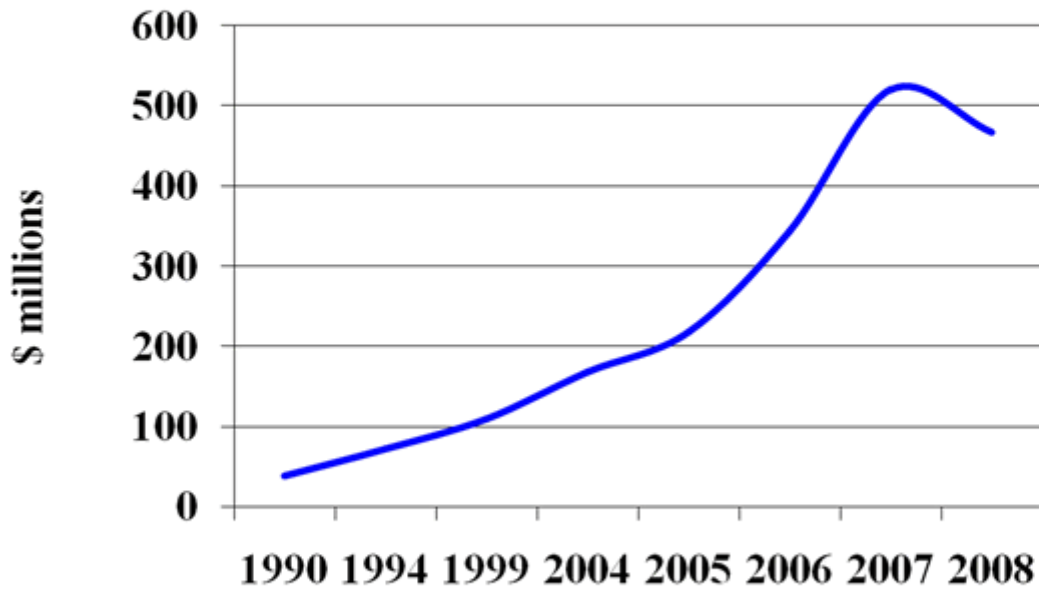
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Williams Advanced Materials develops, manufactures and markets materials, thin film deposition technology and services of unique value for the Magnetic and Optical Data Storage, Medical, Wireless, Photonics, Semiconductor, Optics, Security, Hybrid Microelectronics, Defense and Performance Coating industries. We also have identified key segments on emerging technologies such as Photovoltaic, Solid State Memory, Flexible Cable, and Nanotechnology. Williams' products are primarily based on specialty and unique materials and thin film processes used in high reliability and performance applications.





# *Sales History*

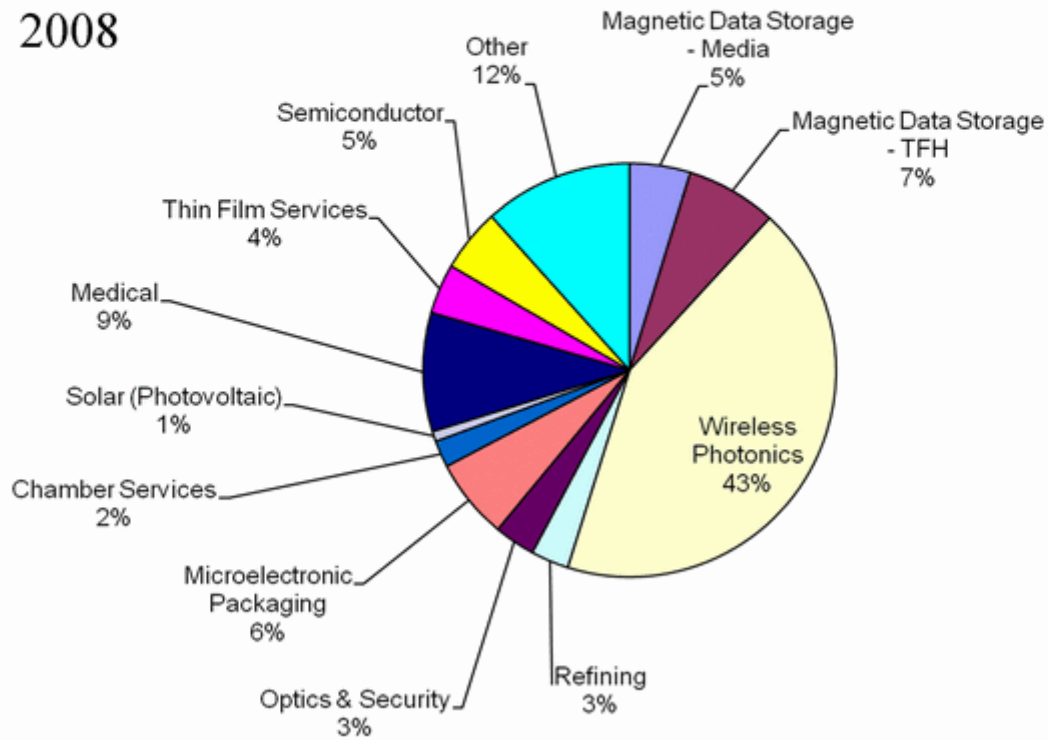


2008  
\$467 Million



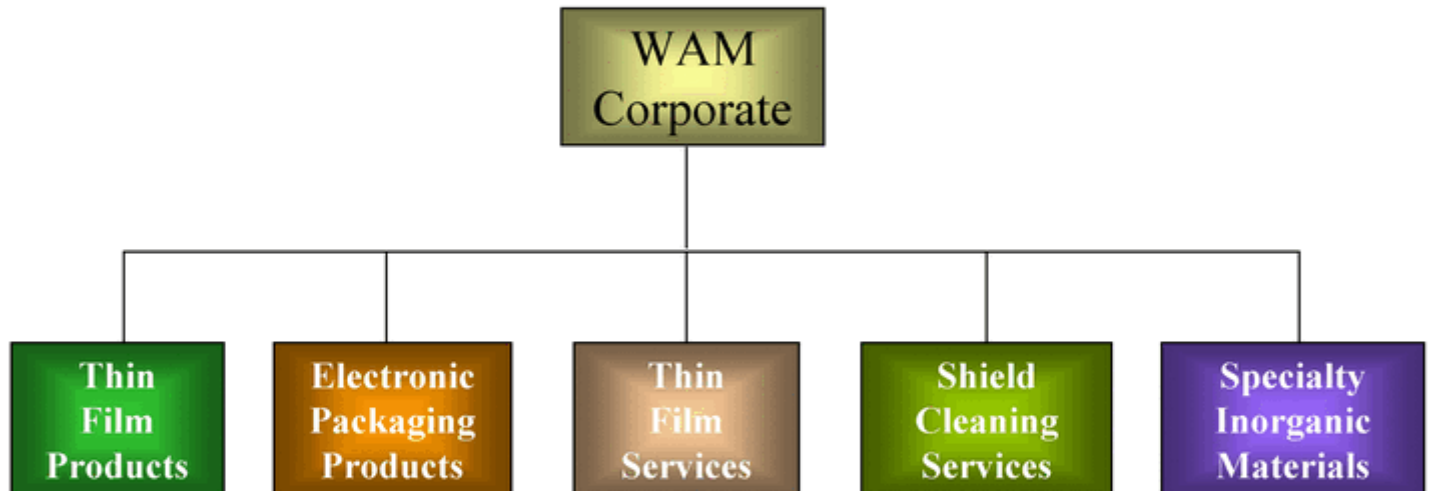
# Revenue by Market

2008



# *2008 Business Structure*

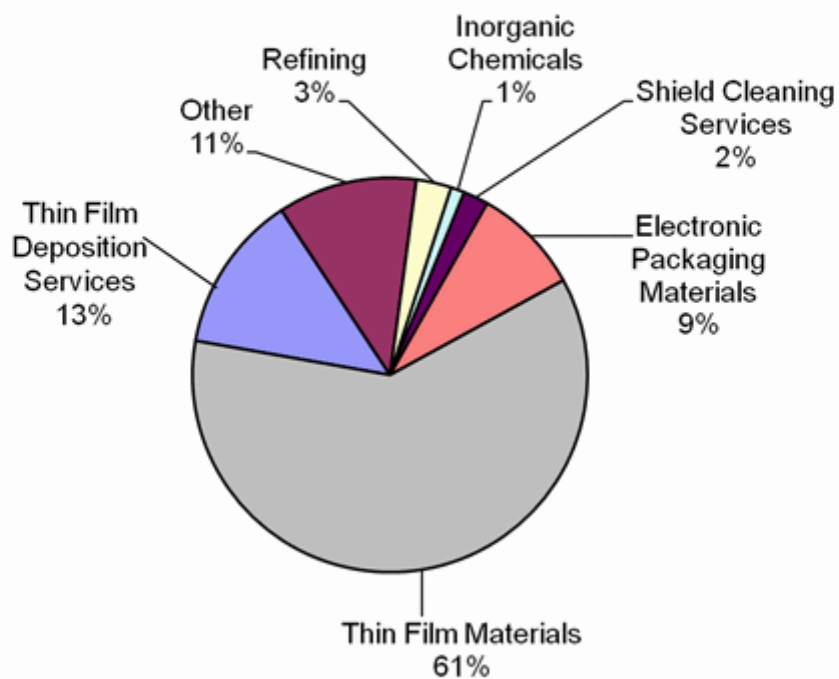
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# *Product Mix*

## *2008*

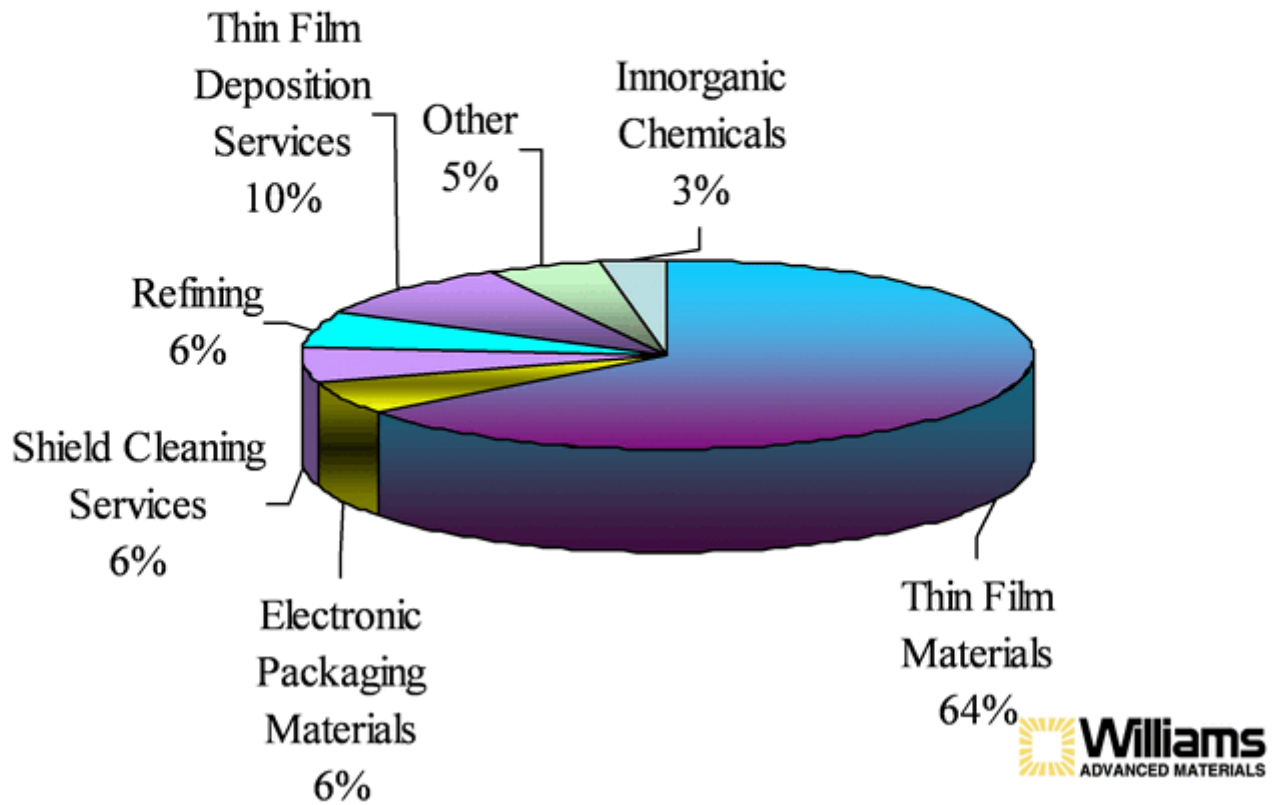
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# Product Mix

## 2007

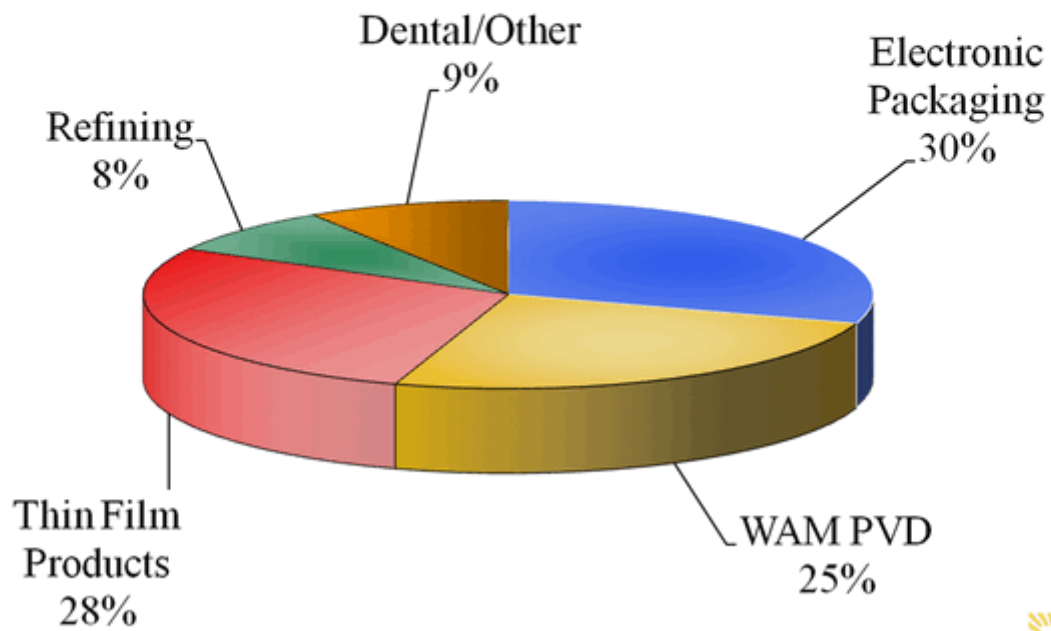
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# *Product Mix*

## *2003*

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# *Augmentation History*

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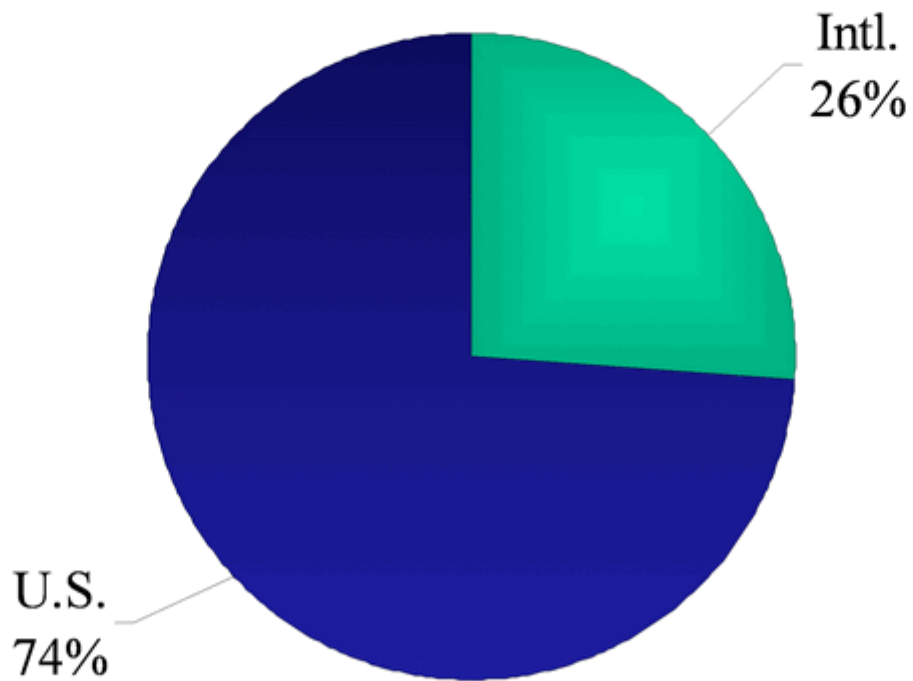
▪ Williams Precious Metals Acquired in	1987
▪ Advanced Materials Technology	1989
▪ Hydrostatics Inc.	1994
▪ Pure Tech Inc.	1998
▪ Wheatfield (Greenfield)	1998
▪ Semi Alloys Inc	2001
▪ Honeywell FLA (Technology)	2003
▪ OMC Scientific Ireland	2004
▪ Thin Film Technology	2005
▪ CERAC inc.	2006
▪ Suzhou, China (Greenfield)	2007
▪ Louny, Czech Republic (Greenfield)	2007
▪ Techni-Met	2008



# *International/Domestic Revenue*

## *2008*

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# *Thin Film Products*

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- **PVD Materials**

- Precious Metal Target Materials
- Non-Precious Metal, Cermets, Ceramics
  - Vacuum Induction Melting
  - Hot Pressing
  - Vacuum Hot Pressing
  - Hot Isostatic Pressing
- EVAPro™ Grade Evaporation Materials
- Localized Target Bonding



- **Chamber Services**

- Shield Cleaning and Conditioning
- Arc Spraying – Electro-polishing
- PM Refining and Upgrading
- Logistics Support

Buffalo

Brewster

Milwaukee

Wheatfield

Singapore

Taiwan

Santa Clara

Ireland

Suzhou,  
China

Louny, Czech



# *Packaging Materials*

---

- FLA/Combo-Lid®
- Seam Seal/Microlid™
- Preforms
- Clad Materials
- Braze Materials
- Ni Alloys
- Dental
- Packages (Zentrix)



Buffalo  
Singapore  
Wheatfield  
Buellton  
WAM  
Taiwan  
WAM Philippines

# *Engineered Thin Films*

---

- Various Deposition Technologies
- Optical Films
- Hybrid Thin Films
- Web Coatings
- CVD Coatings
- Slitting
- Sensors Manufacturing
- Microelectronics Windows



**Buellton, CA**

**Windsor, CT**

# *WAM Headquarters*

---



Buffalo, NY USA –

- 100,000 Sq. Ft. overall, 6,500 Sq. Ft. of clean-room, state-of-the-art machining/ milling/rolling/stamping/ cladding centers, target bonding, high purity refining/recycling, metals casting & automated plating
- Full analytical capabilities, product Research & Development.



# *Specialty Alloys Operations*

---



## Wheatfield, NY

- 30,000 Sq. Ft. with volume vacuum casting, rolling, annealing, powder atomizing and machining. 10 acres for expansion.
- Shield metal recovery and cleaning / Clean room packaging



# *Williams Thin Film Products Operations*

---



## **Brewster, NY USA –**

- 80,000 Sq. Ft. with vacuum melting, hot-pressing, milling, hot & cold rolling, automated machining, grinding, powder metallurgy lab, particle sizing and target bonding capabilities.
- Dedicated R&D staff and capabilities to support rapid new product development in key markets.



# *Techni-Met*

---



## Windsor, CT

- 2 facilities - total of 75,000 sq. ft.
- 48 employees – two (2) shift operations.
- High Value Added Precision Coated Materials.
- Continuous Vacuum Deposition of Inorganic Materials onto Rolls of Flexible Polymeric Films and other Substrates.





# *CERAC*

---



## Milwaukee, WI

- Subsidiary of WAM
- Physical Vapor Deposition (PVD) materials for ophthalmic, optic and performance applications.
- Specialty Inorganic Materials
- Unique technologies in chemical and powder processing





# *Thin Film Technology (TFT)*

---



## Buellton, CA

- Subsidiary of WAM
- Thin film coating and substrate patterning.
- Visi-Lid™ supply chain management.
- Capabilities: Electron Beam Evaporation, DC/RF Magnetron Sputtering, Photolithography (Substrate Patterning), Dicing, Tooling design, In House Machine shop



# *Suzhou - China*

---



## Suzhou, China

- 20,000 Sq ft.
  - Target & Evaporation materials manufacturing, Target bonding services, Distribution, Warehousing, Sourcing, MgF manufacturing and packaging
  - Located near Shanghai Airport and close to many technology centers located in Eastern China.
  - Markets Serve: Semiconductor, UBM, Security and Optics
-

# *Far East Operations*

---

## WAM Far East Ltd.



### Singapore

- Target bonding, bonding wire production, Combo-Lids® assembly



### Subic Bay, Philippines

- Combo-Lids®, low-cost lids and preform - assembly, inspection and packaging.



### Taoyuan County, Taiwan

- Target bonding, evaporation materials & bonding wire.



# *OMC - Limerick*

---



## Limerick, Ireland – OMC Scientific, Ltd.

- Subsidiary of WAM
- Provides precision parts cleaning and reconditioning services for film Physical Vapor Deposition (PVD) customers in Europe.
- Unique technology applied to opportunities in North America and Asia.
- Efforts focused in the semiconductor, magnetic media and other technology based markets.



# *OMC- Czech*

---



## Louny, Czech Republic

- Provides precision parts cleaning and reconditioning services for film Physical Vapor Deposition (PVD) customers in central and eastern Europe
  - State of the art cleaning, stripping and packaging operations
  - Machining capabilities for Optical Media and other PVD segments
  - Markets Serve: Semiconductor, Compound Semiconductor, UBM, MEMS, Data Storage
-

# *Global Service and Support*

---

## ▪ **Sales and Applications Engineering support**

Buffalo, New York  
Brewster, New York  
Tucson, Arizona  
Santa Clara, California  
Buellton, California  
Milwaukee, Wisconsin  
Dallas, Texas  
Windsor, Connecticut

Tokyo, Japan  
Taoyuan, Taiwan  
Singapore  
Manila, Philippines  
London, England  
Seoul, Korea  
Limerick, Ireland  
Shanghai, China

## ▪ **Representative**

Italy  
Germany

France  
Israel

China  
India





# *New Product and Technology Development*

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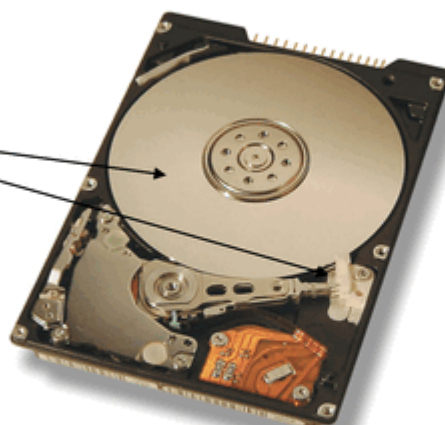
- Optical Filters
- Bio-Sensors
- Materials for Thin Film PV (Solar): Cu(I)Ga(S), CdS, CdTe, TCO Materials, etc
  - Ag Alloys for Solar backside contact
- New Cleaning Methods for Shield Cleaning & Material Reclamation
- Magnetic Data Storage
  - Media Materials; Oxide Gen II and Eco-Ru
  - Head Materials Heusler Alloys & FePt
- Flexible Solar Cells



# Key Markets – Magnetic Head and Media

---

- Sputtering Targets/ Evaporation Materials (Precious Metals, Alloys, Non-Precious Metals, Alloys, Magnetic Materials, Heusler Alloys and Oxides)
- Chamber Services complement materials offering.



*Example – Hard Disk Drive PMR  
Material Stack*

Recording Layer	CoCrPt + Oxide
Orient Interlayer	Ru
Soft Underlayer	Iron & Cobalt Based Alloys
AFC Layer	Ru
Soft Underlayer	Iron & Cobalt Based Alloys
Substrate (Glass or Aluminum)	





# *Key Markets – Wireless and Photonics*

---

Thin Film and Packaging materials for varied wireless and photonic applications including RF Power Amplifiers, HBT's, SAW Devices, Light Emitting Diodes (LEDs), Laser Recorders and Micro Electro Mechanical Systems (MEMS)



# *Key Markets - Thin Film and Electronic Packaging Materials & Services*

## *Night Vision (Defense)*

---

### **Thin Film Deposition Services**

- Coated Infrared Optics
- Hermetic Windows for FPA Packaging
- Flexible Interconnects



### **Williams Thin Film Materials**

- Sputtering Targets for FPA Manufacturing
- High Purity Infrared Coating Materials

### **Electronic Packaging Materials**

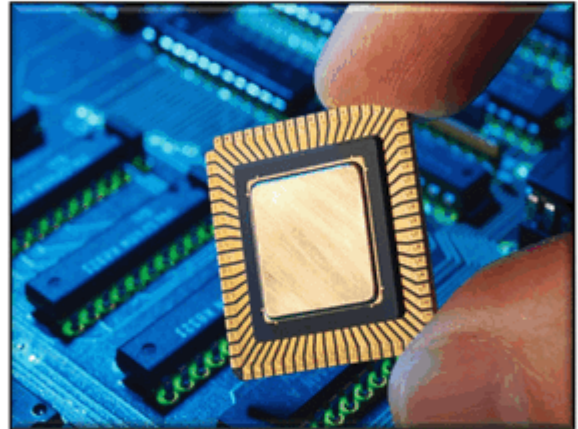
- Precision Machined Components
- High Purity Solder Materials



# *Key Markets – Semiconductor Packaging*

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- High reliability semiconductor packaging materials.
- Applications focused in space, military and satellite market segments.

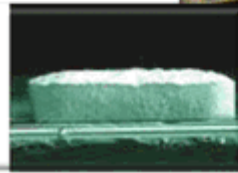
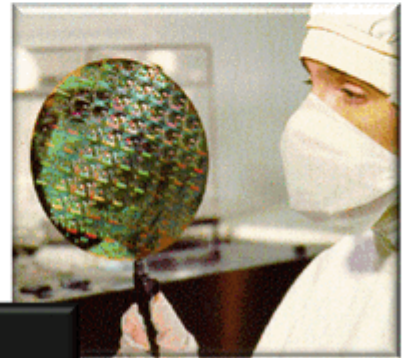
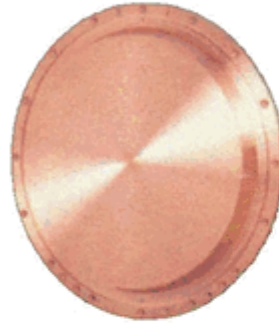


 **Williams**  
ADVANCED MATERIALS

# *Key Markets – Semiconductor Wafer Fabrication*

---

- Thin film materials and chamber services for silicon wafer and UBM (Under Bump Metallization) technologies.
- Numerous commercial and military microelectronic applications.



# Optics Markets

---

- **Security**
  - $\text{ZnS}$ ,  $\text{MgF}_2$ ,  $\text{SiO}_2$
- **Laser optics**
  - $\text{ThF}_4$ ,  $\text{YF}_3$ ,  $\text{SiO}_2$ ,  $\text{Ge}$
- **Communications**
  - $\text{SiO}_2$ ,  $\text{Ta}_2\text{O}_5$ ,  $\text{Nb}_2\text{O}_5$ ,
  - $\text{LaB}_6$  Cathodes
- **Ophthalmics**
  - $\text{SiO}_2$ ,  $\text{Al}_2\text{O}_3$ ,  $\text{Ti}_3\text{O}_5$ ,  $\text{Cr-SiO}$



# *Opto-Electronic Markets*

---

- **Resistor material for hybrid circuits**
  - Cr-Si, W-Ti
- **Projection Display Products**
  - $\text{HfO}_2$ , Cr,  $\text{SiO}_2$ ,  $\text{MgF}_2$
- **Clear conductive coatings**
  - ZnO
- **Data Storage**
- **Photovoltaics (Solar)**
  - CdS, CdTe, Cu-In-Ga-Se



 **Williams**  
ADVANCED MATERIALS



# *Specialty Inorganic Markets*

---

- **Protective coatings for aerospace applications**
  - $\text{TiB}_2$ ,  $\text{B}_4\text{Si}$
- **Defense Applications**
- **Semiconductor gas precursors**
  - $\text{Zn}_3\text{As}_2$
- **Data Storage**
- **Medical devices**
  - $\text{V}_2\text{O}_5$
- **Specialty Batteries**
  - $\text{Li}_2\text{O}$ ,  $\text{CoS}_2$



# *Key Markets - Defense Applications*

## *Aerospace*

---

### **Thin Film Technology**

- Large Area Coating of Irregular Shaped Flight Components
- Coatings on Composite Materials
- Thin film hybrid circuits
- Specialty Engineered Films



### **Williams Thin Film Products**

- Sputter & Evaporation Materials for critical surfaces

### **Williams Advanced Materials**

- Hermetic Combo Lids
  - High Purity Solder Materials
  - Precision Machined Components
-

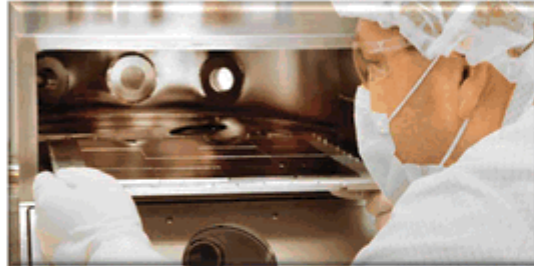


# *Key Markets - Medical (Sensor) Applications*

---

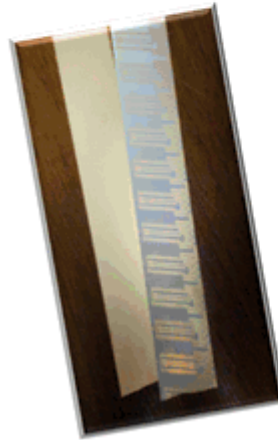
## **Thin Film Deposition Services**

- Batch Sensor Electrode Manufacturing
- Roll to Roll Strip Sensor Manufacturer
- Metal Deposition and Precision Slitting



## **Williams Thin Film Products**

- Sputter & Evaporation Materials for Sensor Manufacturing
- Refining and Recovery
- Shield Cleaning Services



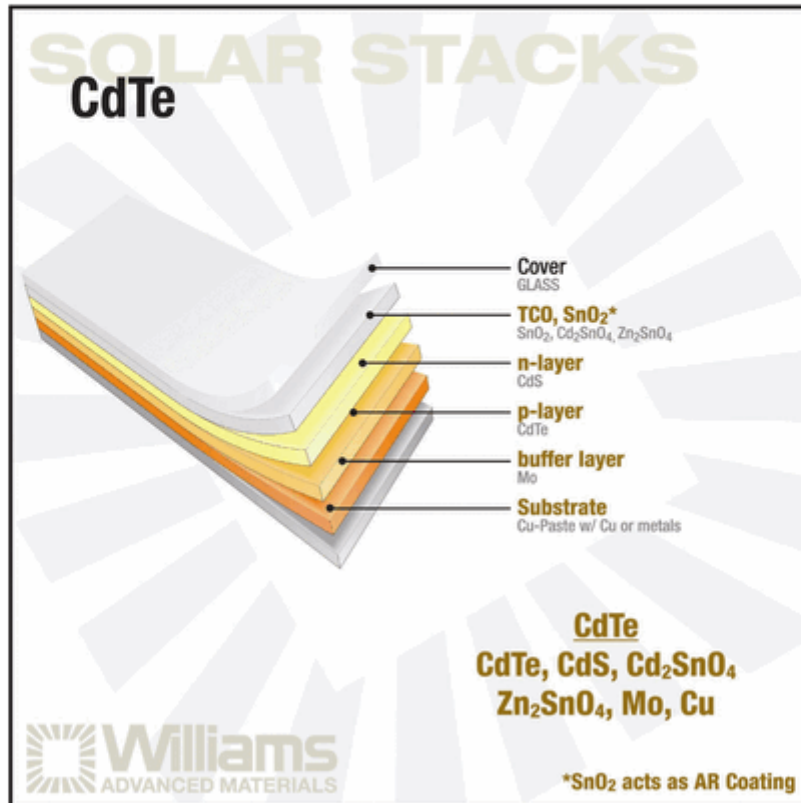
# *Photovoltaic Solar Applications*

---

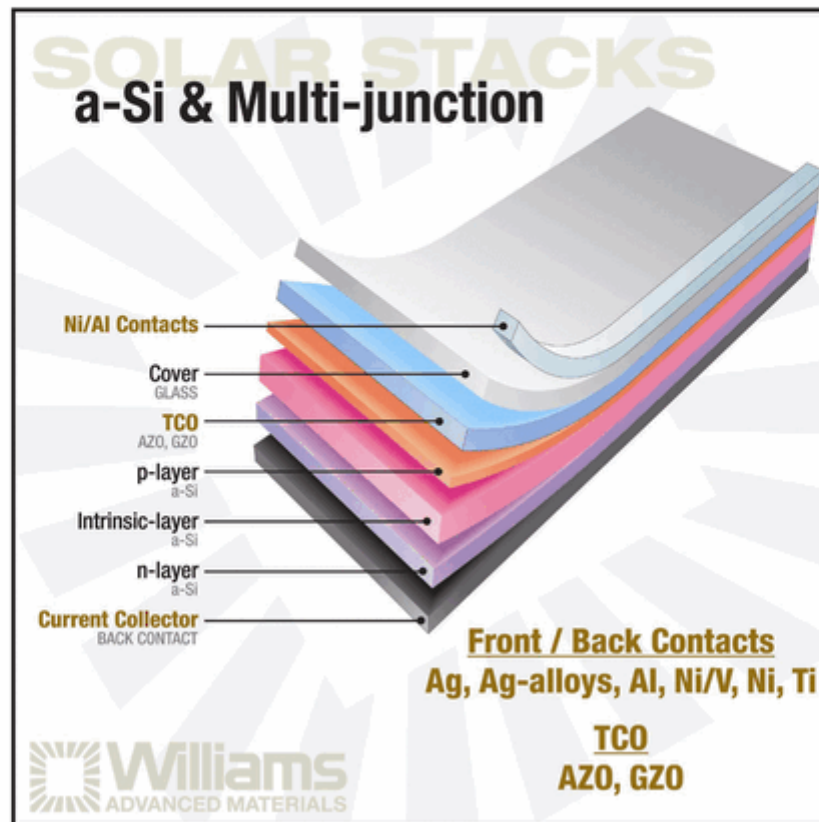
- **Thin Film Materials**
  - Targets and Evaporation
  - CIG(S), CdTe, CdS, AZO, GZO, Ag, Ti, Al, CuGa
- **Thin Film Deposition Services**
  - TCO Coatings (ITO)
  - R&D Thin Film Stack Development
- **Chamber Services**
  - PVD, PECVD Shield Sets
  - Added Value Services



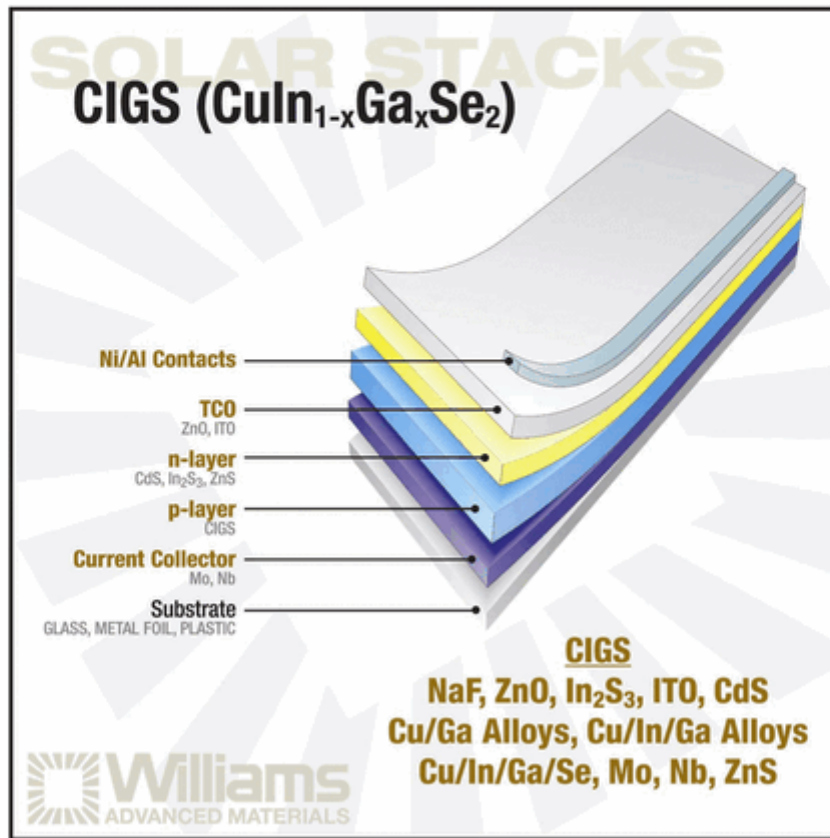
# Solar Stacks: CdTe



# *Solar Stacks: amorphous Si*



# Solar Stacks: CIGS ( $\text{CuIn}_{1-x}\text{Ga}_x\text{Se}_2$ )



# *Global Chamber Services Value Package*

---

- **Shield Cleaning Services Improve raw material utilization, precious metal recovery and equipment uptime improvements**
- **Mechanical and chemical recovery techniques**
- **Shield Surface treatment capabilities**
- **Clean Room environment and packaging**
  - Ultrasonic cleaning with particle count monitoring
  - Drying a.k.a. baking a.k.a. out gassing
  - Clean room packaging
  - SPC Data collection
- **Custom final packaging**
- **Precious Metal Management**
- **Logistics support**



# *Chamber Services/Refine*

---





# *Distinctive Competencies*

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# *New Horizons*

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- TDP, Solar — Rotatable Targets
- FCCL
- Medical Sensors
- Global Chamber Services
- Optical Sensors Fabrication
- Solar Energy-packaging, inorganic compounds, metal/alloy solutions
- Flexible Solar Solutions
- OLED Displays
- IR Coatings and Packages



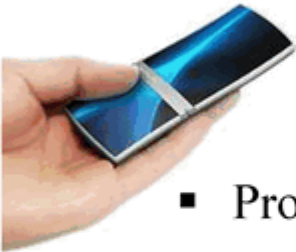
*Brush Engineered Materials Inc.*  
*Organized into Four Separate Reportable Segments*

---

- Advanced Material Technologies and Services
  - ***Specialty Engineered Alloys***
  - Beryllium and Beryllium Composites
  - Engineered Material Systems
-

# *Brush Specialty Engineered Alloys & Brush Resources Vision*

---



- Provide *technical expertise* and *flexible services* to deliver value through *innovative, practical engineered material solutions*.
- Our *products and services* coupled with our *global distribution and logistics network* are relied upon by our customers making us their *trusted growth partner*.



# *Brush Specialty Engineered Alloys & Brush Resources Mission*

---

*Safely* and *reliably* provide the *highest quality*, *innovative* products and services, *fast* and *on-time* to all customers, when they want them at the *lowest possible cost*.



# *Specialty Engineered Alloys (Alloy Products)*

## *Operations Strategy—Lean Sigma*

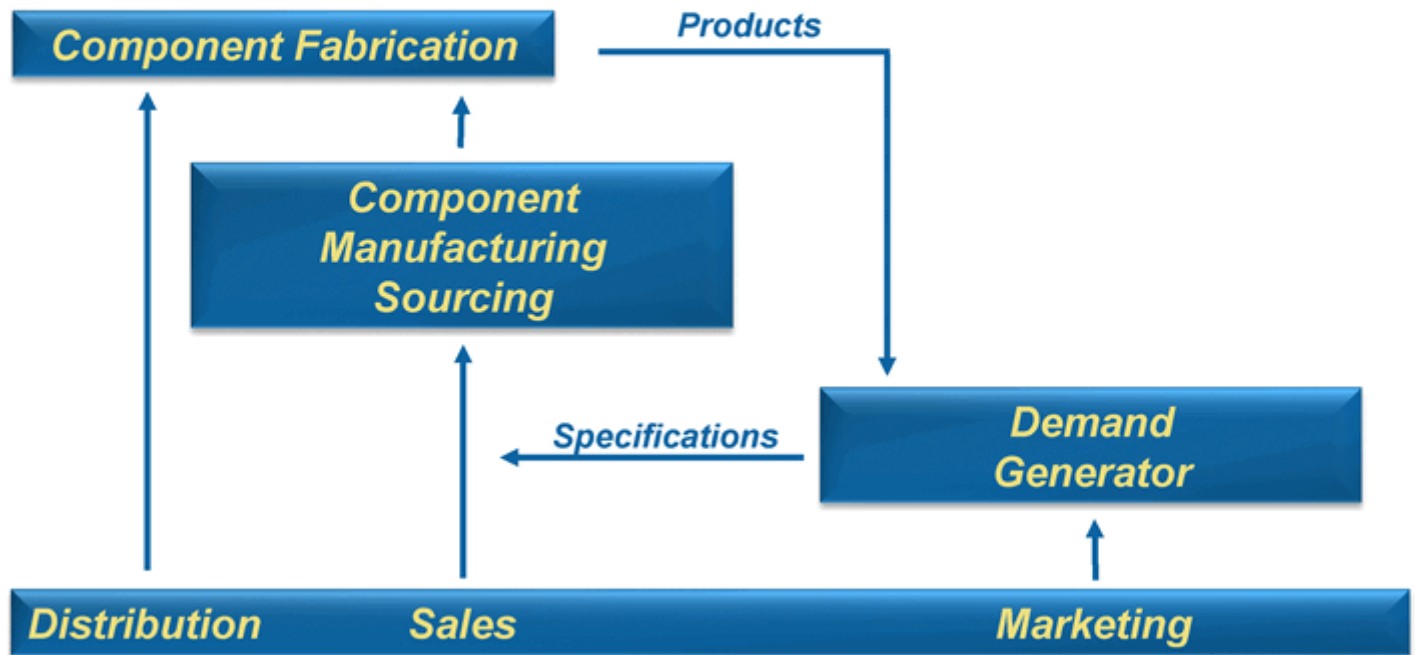
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- *Safety* practices to provide an injury and illness free workplace
- *Lean Manufacturing* to reduce cycle times, further increase capacity, and provide industry leading service to our customers
- *Six Sigma* to provide industry leading product quality and to reduce costs
- *Supply Chain Management* to provide exactly what is needed, when it's needed, to where it's needed in exactly the right quantity
- *Total Productive Maintenance* to provide industry leading equipment reliability



# *Sales Based on End User Specifications*

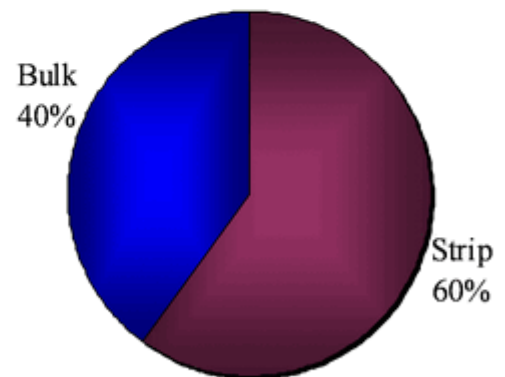
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# *Brush Specialty Engineered Alloys*

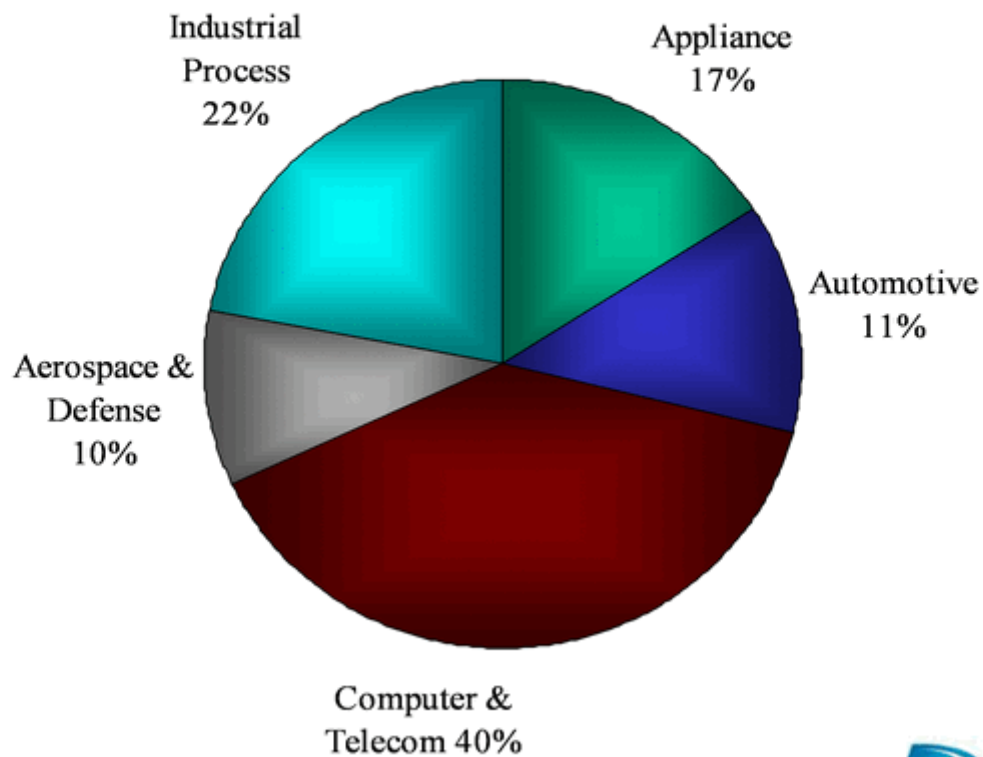
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- The primary business within the Specialty Engineered Alloys Segment, Alloy Products sales for the year 2008 were \$292 million.
- Manufactures and sells copper and nickel based alloy systems and components metallurgically tailored to meet customers' specific performance requirements
- Product families:
  - Strip products include thin gauge precision strip and thin diameter rod and wire. These products provide a combination of high strength, formability and electrical conductivity for connectors, contacts, switches, relays and shielding used in mobile communications devices, wireless communications equipment, storage area network systems, data networking equipment, servers, notebooks, netbooks, plasma & LCD HD televisions, medical electronics, appliances, and automotive electronics.
  - Bulk products include rod, bar, tube and plate. These products are known for superior strength, corrosion and wear resistance, thermal conductivity and lubricity. Applications include bearings and bushings for aerospace and heavy equipment, resistance welding components, oil & gas drilling components, plastic mold tooling and telecommunications housing equipment.



# *Alloy Products Revenue by Market Year 2008*

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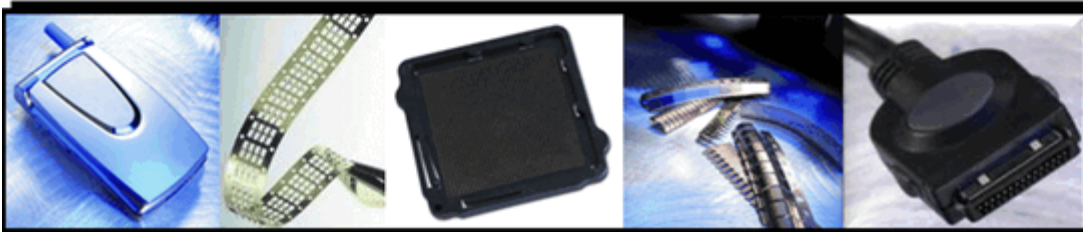


# *Strip Alloy Applications*

*(strength, conductivity, spring characteristics)*

---

- Automotive electronics
- Appliance switches
- Pressure Responsive Devices
- Fire Extinguisher Sprinkler Heads
- EMI Shielding
- Current Carrying Springs and Relays
- Integrated Circuit Sockets
- Electrical and Electronic Connectors in Mobile Handsets, PDAs, Base Stations, Storage Area Networks, Servers, Notebooks, Netbooks, Plasma & LCD HD Televisions and Medical Electronics



**BRUSH**  
WELLMAN  
ALLOY PRODUCTS

# *Strip Products - Strategy*

---

- **Maintain focus on major end-use markets**

- Computer
- Telecommunications (mobile & Infrastructure)
- Automotive
- Appliance
- Military
- Medical
- Consumer electronics



- **Defend leadership in traditional alloy strip, rod & wire**

- Reduce total cost of manufacture to allow penetration of mid-range alloy applications
- Enhance product properties to provide additional value to customers

- **Introduce new alloys to meet needs of targeted market opportunities**

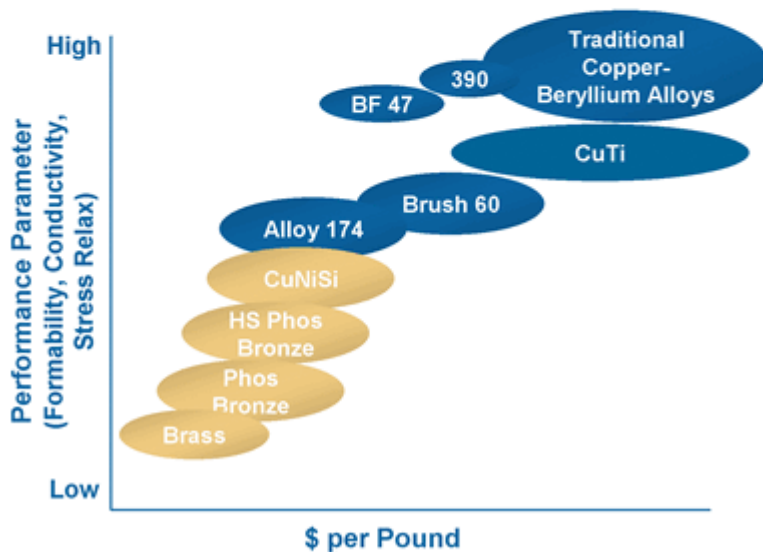
- **Geographic Growth**



# Strip Products Strong Value Proposition

*Copper-beryllium alloys, while premium priced, provide best-in-class performance*

## Competitive Alloy Comparison



Note: Blue denotes Brush Engineered Materials' alloys; beige represents competitive materials.

## Brush Value Proposition

- Unique, high-performance materials
- Technical design capabilities
- Outstanding service center network
- Global marketing, sales and distribution

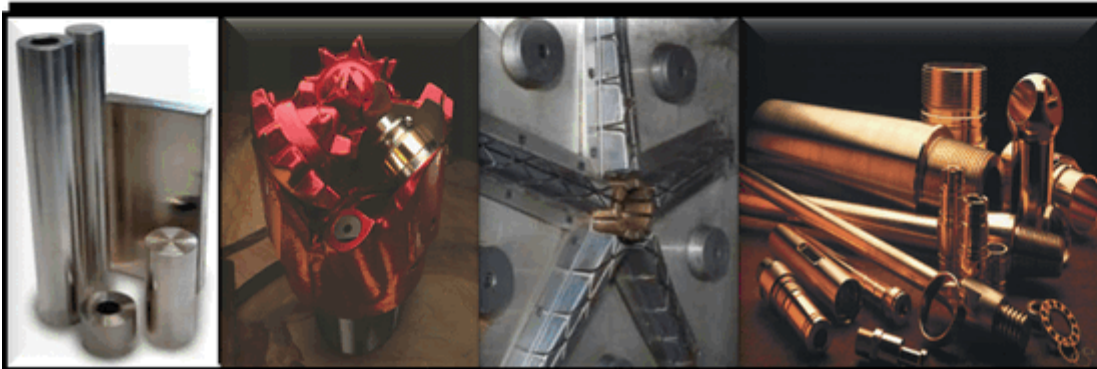


# *Bulk Alloy Applications*

*(strength, corrosion resistance, non-galling, conductivity)*

---

- Aircraft Bushings
- Heavy Equipment Bearing and Wear Applications
- Oilfield well drilling, completion and production equipment
- Plastic Injection & Blow Molds
- Power Generation
- Tooling for Metalworking
- Undersea/Marine Hardware for Telecom & Instrumentation
- Welding Electrodes & Dies



**BRUSH**  
WELLMAN  
ALLOY PRODUCTS

# *Bulk Products - Strategy*

---

- **Maintain focus on traditional end-use markets**
  - Aerospace
  - Oil & Gas
  - Plastics
  - Power Generation
  - Resistance Welding
  - Undersea
- **Introduce new alloys or product forms to meet needs of targeted market opportunities**
- **Focus on new non-traditional growth markets**
  - Bearings, Heavy Equipment & Mining, Marine, advanced Oil & Gas well components, Offshore & Downhole technology, and Pumps
- **Grow Existing business in finished and semi-finished components**
  - Offer design assistance and one-stop shopping to end users
- **Geographic Growth**
  - Expand commercial operations in Asia Pacific (including India) and Eastern European markets, improve customer awareness and distribution





# *MoldMAX<sup>®</sup> Alloys for the Plastics Industry*

---



Our engineers use infrared imaging at the customers' facility to pinpoint where MoldMAX<sup>®</sup> will provide the maximum benefit.

## **Value Proposition**

- Provides molders with 20-40% increase in productivity
- Capital avoidance due to increased productivity
- Enables improved quality of molded parts
- ROI < 3 months

## **Technical advantages**

- Hardness of steel with the thermal conductivity of copper
- Fast machining rates
- High polishability



# *Lorain Casting Facility*

## *Spinodal and EquaCast® Technology-Winning!*

---

High performance copper based engineered materials:

- Strength and hardness is comparable to copper beryllium products
- Thermal conductivity

The value proposition differentiates:

- Corrosion resistance
- Superb tribological properties (low friction, excellent wear resistance) adding value in reliability, uptime, and maintenance savings
- Machinability and design simplicity adding cost benefits to offset increased material costs
- Casting capability including size, shapes, tubes and quality
- No EH&S issues

Developing applications in markets where we are strong:

- Drilling Equipment, Aircraft Parts, Mold Tooling

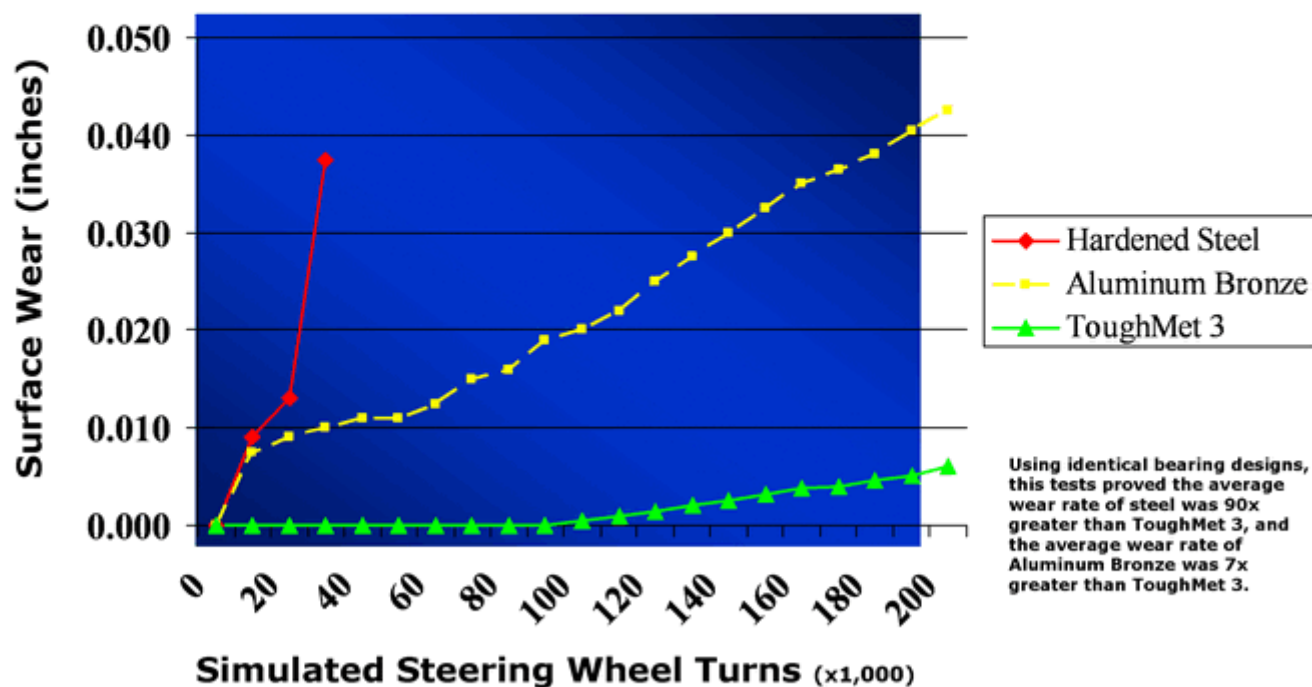
Developing markets/applications where technology is strong:

- Oil Well Completion Equipment, Mining, Heavy Equipment, Drivetrain Components, Hydraulic Systems, Engine Bearings, Semiconductor Fabrication

Lorain Technology: Expanding market and application reach



# *ToughMet® Outlasts Conventional Bearing Materials in 300-ton Mining Truck Steering Test*



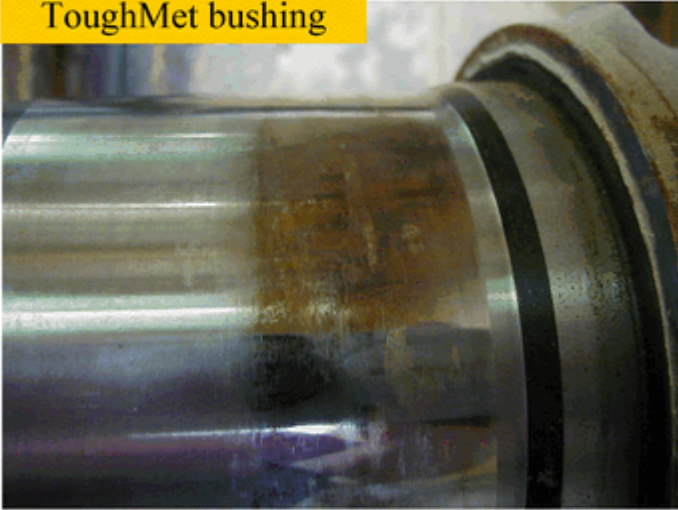


# *ToughMet® Bushings Protect Steel Mating Parts.*

## *Example: Lubrication failure on bulldozer undercarriage*

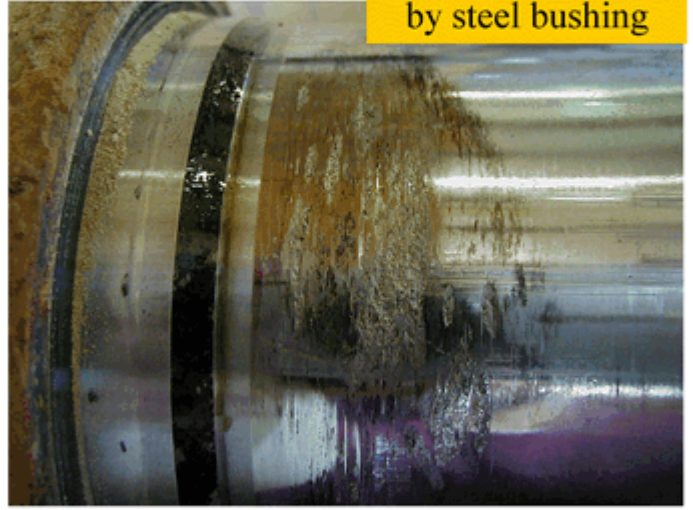
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Steel pin protected by  
ToughMet bushing



Left side pin after 500 running hours  
against ToughMet 3 CX105 bushing.

Steel pin damaged  
by steel bushing



Right side pin after 500 running hours  
against hardened steel (HRC 50)  
bushing.

Pin hardness = HRC60.

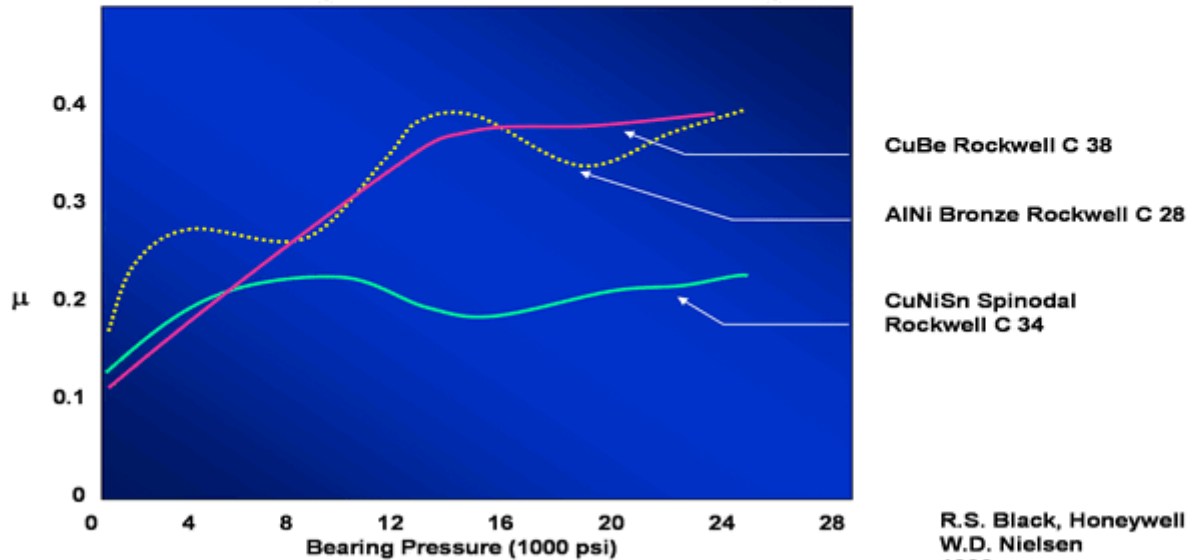


# *ToughMet<sup>®</sup> Industrial Components Results:*

---

## **ToughMet<sup>®</sup> Alloy Bushings Provide Superior Power Efficiency Performance**

in a Comparison of Dynamic Coefficient of Friction  $\mu$  vs  
Bearing Pressure for Three Bearing Materials



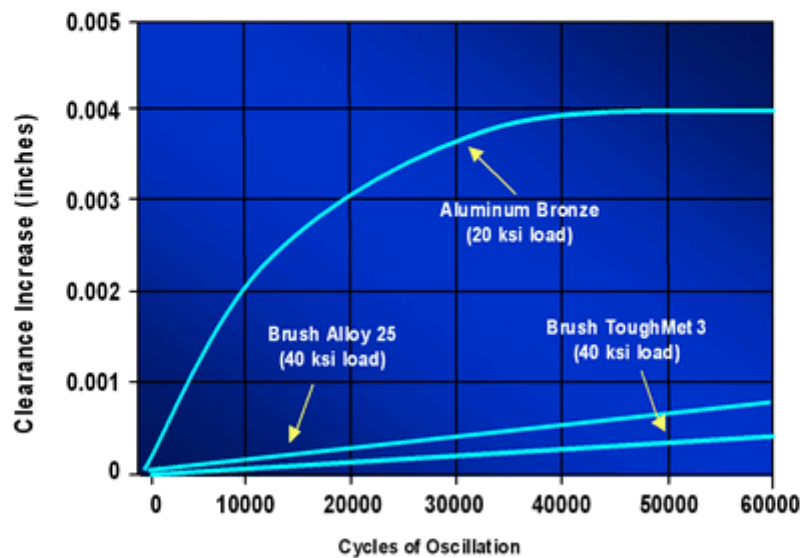
R.S. Black, Honeywell  
W.D. Nielsen  
1996



# *Significantly Higher Durability has been Confirmed for ToughMet®*

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## Comparative Sleeve Bearing Wear Tests.



Battelle

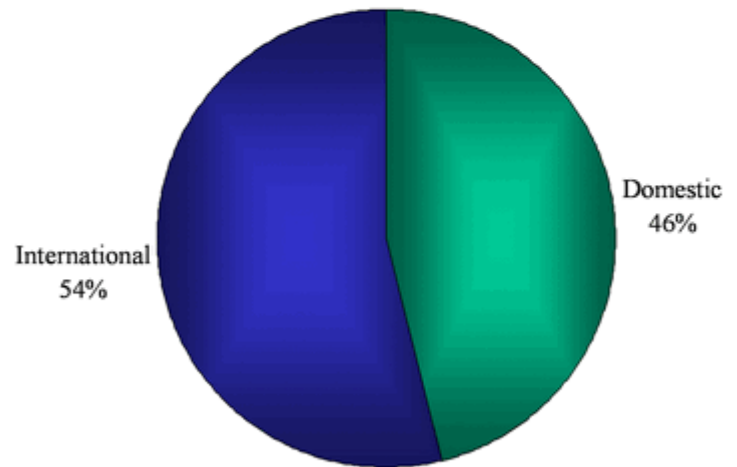


# *Brush International, Inc.*

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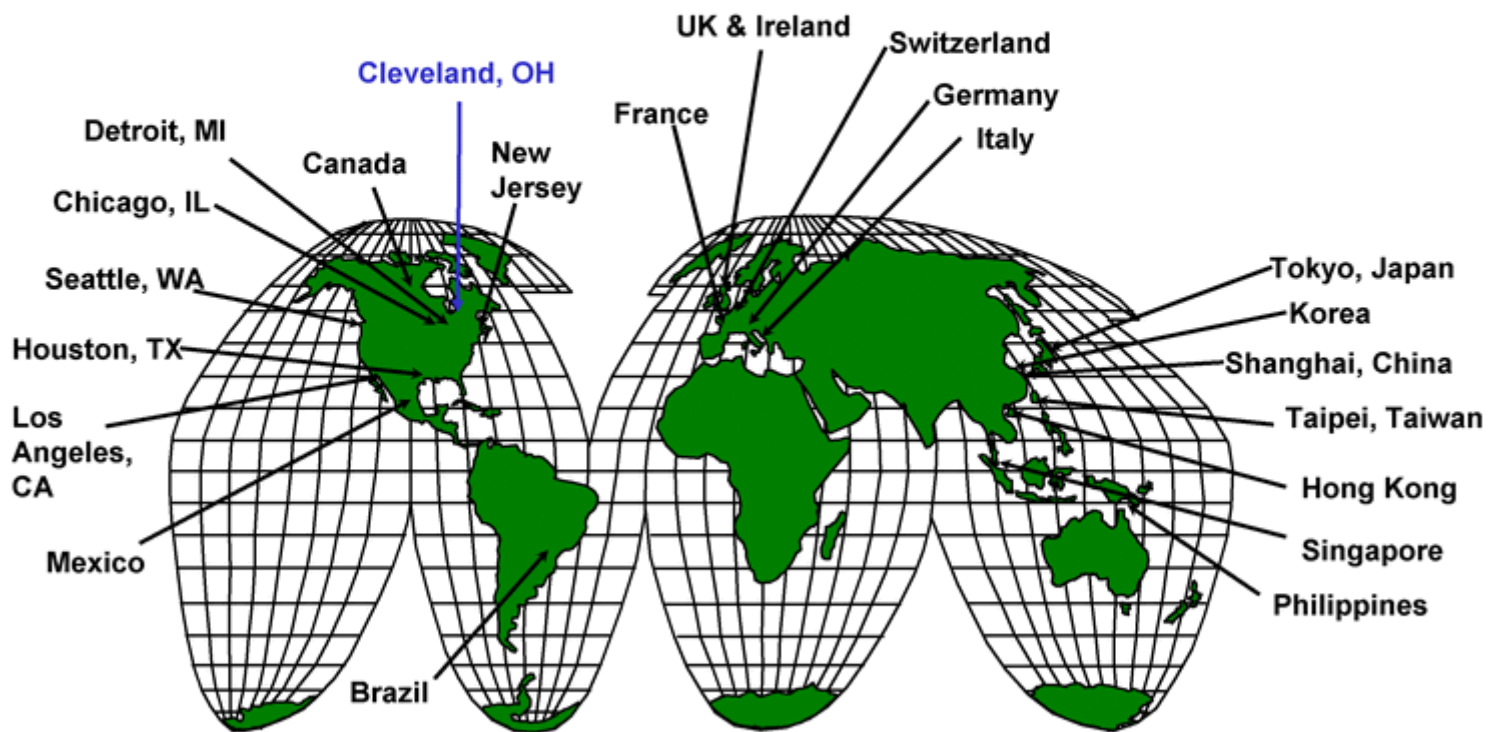
- Brush International Inc. is a wholly owned subsidiary of Brush Engineered Materials
- Service centers in Germany, England, Japan and Singapore
- Representative offices in Korea, China and Taiwan
- Primary focus on the distribution of alloy products while providing local support to other Brush Engineered Materials' subsidiaries operating internationally

*Alloy International/Domestic Revenue  
Year 2008*



# *Global Sales and Distribution Network*

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*Global Reach..... Local Service*

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*Brush Engineered Materials Inc.*  
*Organized into Four Separate Reportable Segments*

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---

- Advanced Material Technologies and Services
  - Specialty Engineered Alloys
  - ***Beryllium and Beryllium Composites***
  - Engineered Material Systems
-

# *Beryllium and Beryllium Composites*

## *Comprises two business units*

---

- Brush Beryllium Products
- Brush Ceramic Products



# *Brush Beryllium Products*

---

## Products

Beryllium Metal - One of the lightest metals known

- Family of vacuum hot and hot/cold isostatically pressed powder-derived metals

AlBeMet™

- Family of lightweight alloy composites
- Extruded, rolled sheet and hot isostatically pressed powder-derived metals

**BRUSHWELLMAN**  
ENGINEERED MATERIALS

---



# *Brush Beryllium Products*

---

## Products - Cont.

- E-Materials
  - Family of low expansion, lightweight electronic packaging materials
  - Composites of beryllium metal and beryllium oxide
- Beryllium Oxide/  
Chemicals
  - Ceramic-grade beryllium oxide powder
  - Specialty beryllium-containing chemicals

# *Brush Beryllium Products*

---

## Facilities

Elmore, Ohio

Fremont, California

# *Brush Beryllium Products*

## *Key Product Attributes*

---

- Be/AlBeMet™
  - Light Weight (Density)
  - High Stiffness (Elastic Modulus)
  - High Thermal Conductance/Capacity
  - Low Thermal Expansion
- Be
  - Transparent to X-Rays
  - Neutron Reflector

# *Brush Beryllium Products*

---

## Primary Competition...Alternative Materials

Organic Composites (e.g. Carbon epoxy)

Silicon carbide

Metal Matrix Composites (e.g. Al - silicon carbide)

Pyrolytic graphite

Aluminum (high strength grades)

# *Major Defense/Aerospace Applications for Brush Beryllium Products*

---

## Optics

Optical substrate and support structure for visual and infrared target acquisition systems (fighter aircraft, helicopters, unmanned aerial vehicles, tanks), surveillance systems and astronomical telescopes.

## Satellites

Structures and sensors for defense and commercial telecommunications satellites.

## Electronics

Electronic packaging for defense avionics, radar and electronic countermeasures systems for helicopters and fighter aircraft. Applications include circuit boards, covers and packages.

**BRUSHWELLMAN**  
ENGINEERED MATERIALS

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# *Major Commercial Applications for Brush Beryllium Products*

---

## X-ray Windows

Radiographic tube components for medical diagnostic (x-ray, mammography, CAT-scan), industrial and scientific equipment.

## Optical Scanners

Mirrors for laser scanners used in reprographic and other high-performance laser applications.

## Motion control

Structural components for high-precision semiconductor processing and industrial robotic equipment

## Acoustics

High performance speaker components

# *Major Applications, New Products and Platforms*

---

## *Brush Beryllium Products*

<u>Product</u>	<u>Market</u>
New AlBeMet Products	Defense
Fabricated Products	Defense
Acoustic	Speakers
High grade Be foil	Medical x-ray

# *Beryllium Products*

## *Brush Ceramic Products*

---

- Located in Tucson, Arizona
- Products
  - Ceramic substrates used in commercial and military packaging applications
  - Ceramic laser bores for gas lasers used in medical and industrial applications
  - Machined ceramic components used in military, oil and gas, semiconductor and microwave applications

**BRUSHWELLMAN**  
ENGINEERED MATERIALS

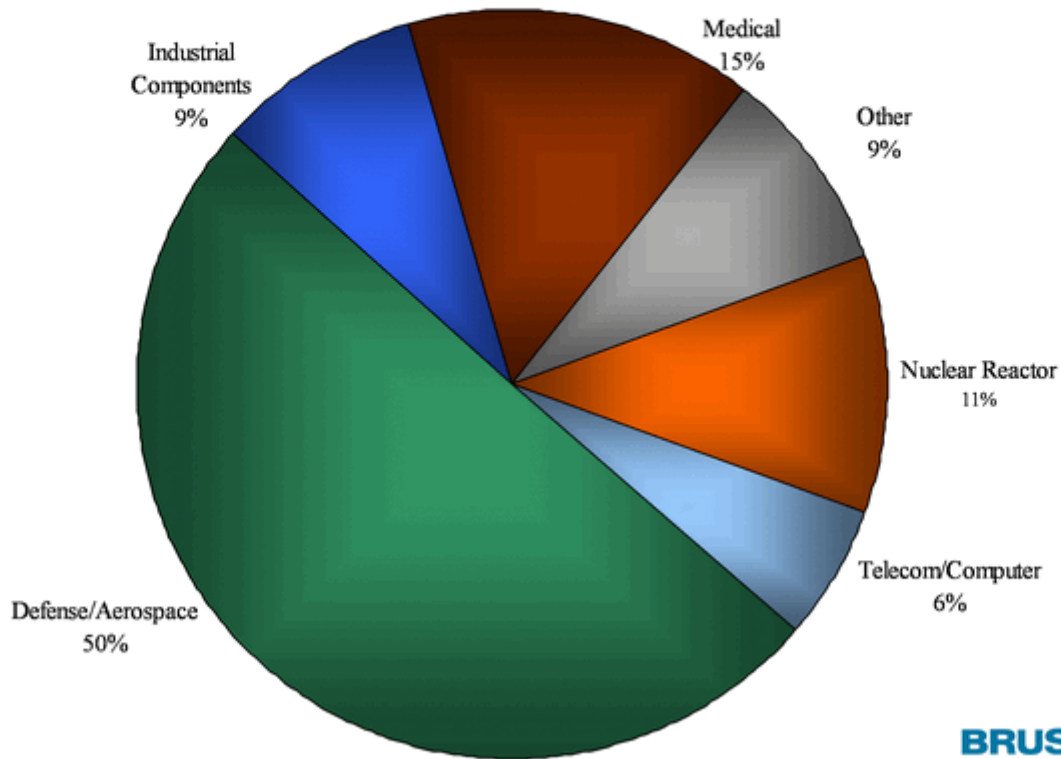
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# *Beryllium and Beryllium Composites*

## *2008 Revenue by Market*

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**BRUSHWELLMAN**  
ENGINEERED MATERIALS

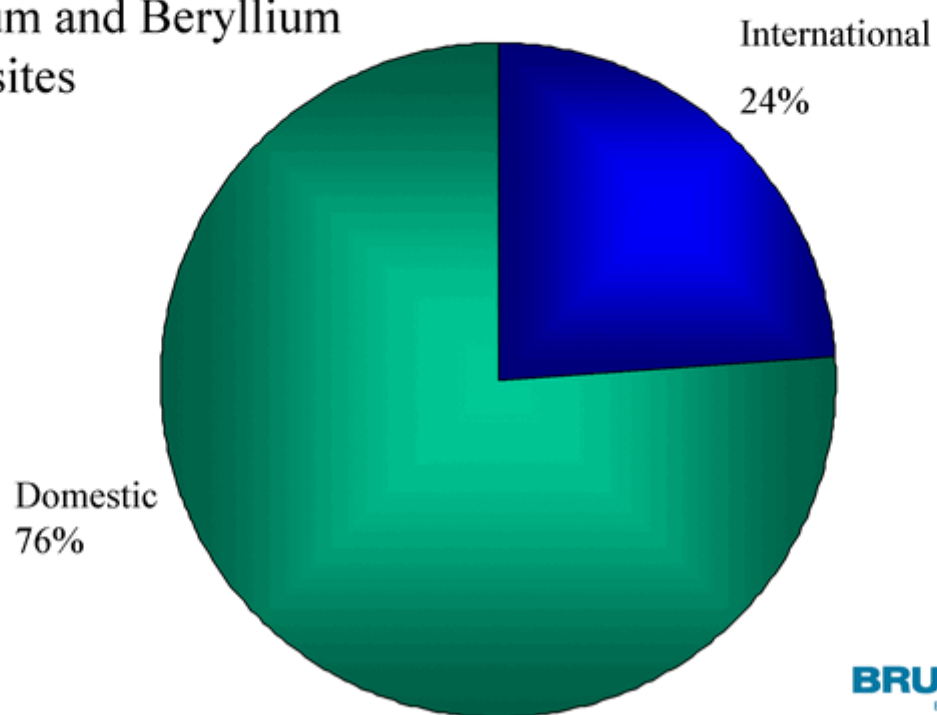
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# *International/Domestic Revenue*

## *2008*

---

Beryllium and Beryllium  
Composites



**BRUSHWELLMAN**  
ENGINEERED MATERIALS

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*Brush Engineered Materials Inc.*  
*Organized into Four Separate Reportable Segments*

---

- Advanced Material Technologies and Services
  - Specialty Engineered Alloys
  - Beryllium and Beryllium Composites
  - ***Engineered Material Systems***
-

# *Engineered Material Systems (Technical Materials Inc.) - 2008*

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“Providing engineered metal strip products to leading technology manufacturers around the world.”

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## *Market History*

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- Founded in 1968, TMI's continuous clad and inlay technology produced high-reliability connector and switch materials for the telecom industry.
  - Today TMI's products are used throughout the world by virtually all major technology markets. As a leader in reel-to-reel composite metals engineering, TMI differentiates itself through proprietary process technologies.
  - TMI worldwide sales continue to increase and in 2008 additional inroads were made in Europe and Asia.
  - In 2008, New Product Sales accounted for approximately 37% of TMI's sales volume.
-

# *TMI Process Technologies*

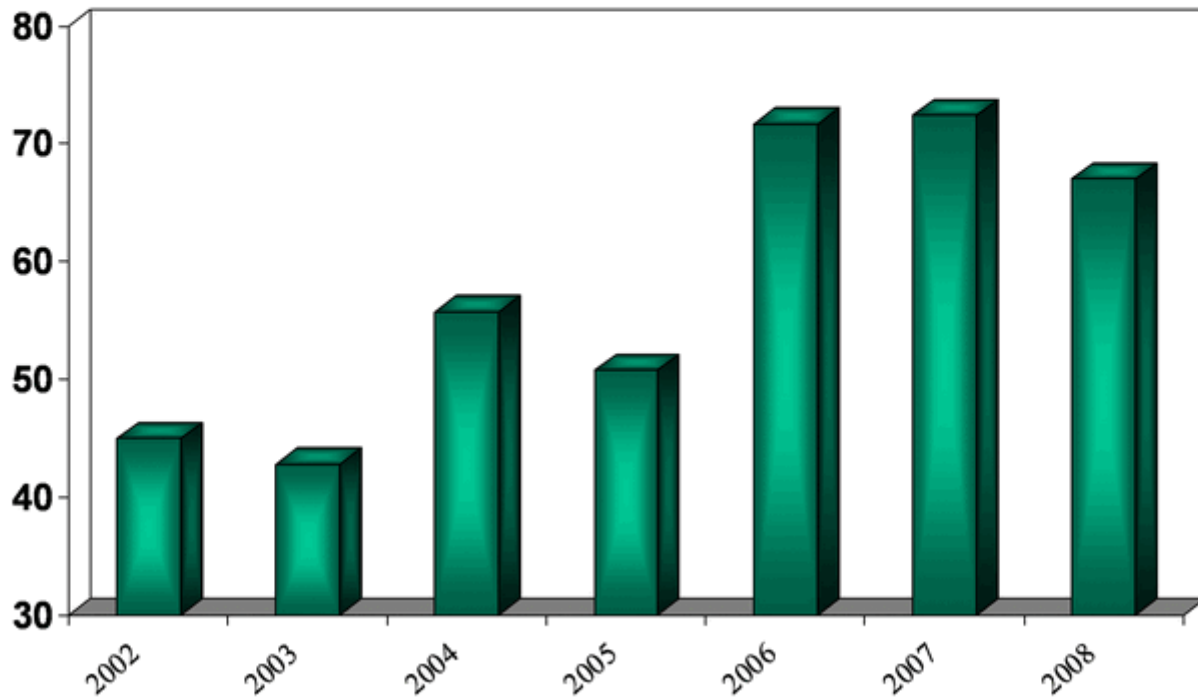


- 
- Cladding
    - Inlay
    - Micro Laminates
  - Electroplating
    - Gold, Silver, Base Metals
    - Selective and Overall Coatings
  - Fabricated Components
  - Profiling
    - Milling
    - Skiving
  - Continuous Electron Beam Welding
  - Lead-Free Solder Coatings
-

# *TMI Historical Sales*

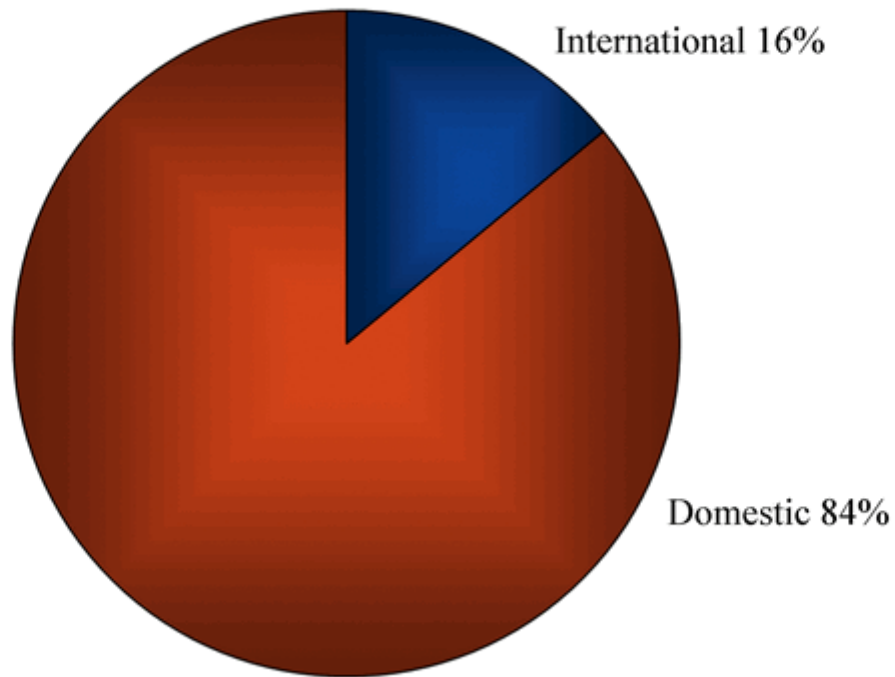


\$ in millions



# *International/Domestic Revenue* 2008

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# *Our Vision*



- 
- To be a leader in creating innovative engineered material solutions and services that make our customers competitive in global markets.
-

# *Technology Leader*

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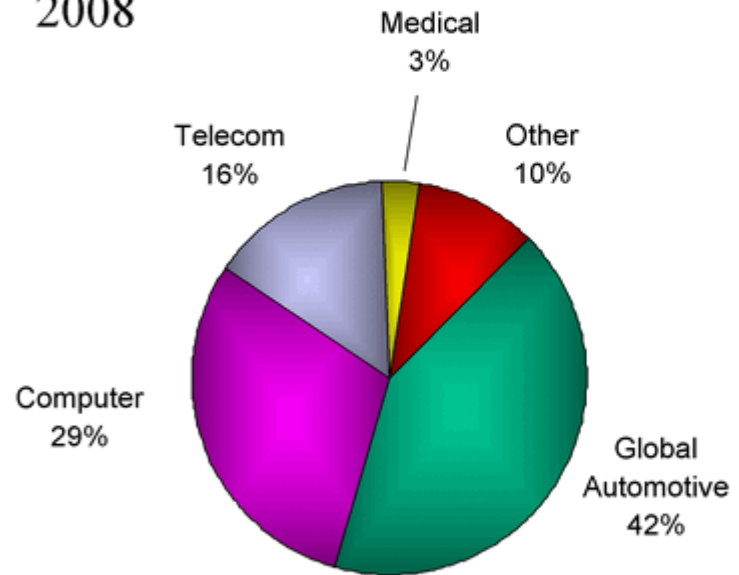
- Quality
    - ISO 9001-2000, Certified by Bureau Veritas
    - ISO 14001, Certified by TÜV
    - Unique Tolerance Capabilities
    - Extensive Digital and Vision-Controlled Processing
  - Engineering
    - Metallurgical Design
    - Technical Customer Support
-

# *Our Major Markets*



2008

- Global Automotive
- Telecom
- Computer
- Medical
- Other



# *Strategic Growth Markets*

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- Alternative Energy Systems
  - Power Electronics
  - Hybrid & Electric Vehicle Materials
  - Hard Drives
  - Medical Devices
-

## *Application: Energy*

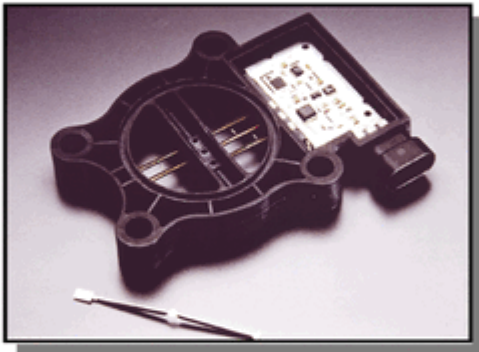
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- High-Performance Lithium Battery Materials
  - Solar Cell Interconnects
  - High-Temperature Fuel Cell Materials
-

# *Application: Automotive Electronics*

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- *High-Reliability Connector and Leadframe Materials*
    - Safety Devices
    - Engine Performance Sensors
    - Hybrid & Plug-In Components
    - Power Electronics
-



## *Application: Computer*

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### ▪ *Hard Drive Suspension Materials*

- Stainless and Aluminum Composites
  - Precision Surface and Thickness Controls
-

# *Application: Medical*

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## ▪ *Precision Stainless Composites*

- Ultra-Precision Toleranced Cutting Materials
  - Electron Beam Welded and Clad Interconnects
  - Electroplated Drug Delivery Electronics
  - Niobium, Tantalum, and Titanium Specialty Materials
-



# *Application: Consumer Electronics*



- Leadframes for Digital Camera Sensors
- Cell Phone Passive Components
- Specialty Clad Materials

# *2009 Growth Strategy*

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- Focus on Clad, Electroplate and Electron Beam Weld Product Development in High-Growth Niche Markets
  - Continued Expansion of Unique Process Capabilities for Value Add Growth
  - Continue to Expand TMI's Presence in the Far East and Europe
  - Continued Emphasis on New Strategic Markets
-

# *Beryllium Health and Safety*

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*Brush has continued to make progress on issues related to beryllium health and safety*

- Improved worker protection programs in place
- Rates of sensitization down among new workers
- Strong focus on regulations related to beryllium exposure



# *Litigation*

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	<u>Total Cases Pending</u>	<u>Total Plaintiffs (including spouses)</u>
12/31/07*	9	31
3/28/08	8	30
6/27/08	8	30
9/26/08	9	36
12/31/08	9	36

\*One case (involving one plaintiff) had been voluntarily dismissed by the plaintiff during the fourth quarter of 2007, but the Company was not made aware of this until 2008.

